Features

- 2,432 x 2,432 non-blocking switching among local streams
- 4,096 x 2,432 blocking switching between backplane and local streams
- 2,048 x 2,048 non-blocking switching among backplane streams
- Rate conversion between backplane and local streams
- Rate conversion among local streams
- Backplane interface accepts data rates of 8.192 Mb/s or 16.384 Mb/s
- Local interface accepts data rates of 2.048 Mb/s, 4.096 Mb/s or 8.192 Mb/s
- Sub-rate switching (2 or 4 bits) configuration for local streams at a data rate of 2.048 Mb/s
- Meets all the key H.110 mandatory signal requirements including timing
- Per-channel variable or constant throughput delay
- Per-stream input delay, programmable for local streams on a per bit basis
- Per-stream output advancement, programmable for backplane and local streams
- Per-channel direction control for backplane streams
- Per-channel message mode for backplane and local streams
- Per-channel high impedance output control for backplane and local streams
- Compatible to Stratum 4 Enhanced clock switching standard
  - Integrated PLL conforms to Telcordia GR-1244-CORE Stratum 4 Enhanced switching standard
  - Holdover Mode with holdover frequency stability of 0.07 ppm
  - Jitter attenuation from 1.52 Hz.
  - Time interval error (TIE) correction
  - Master and Slave mode operation
- Non-multiplexed microprocessor interface

Ordering Information

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<td>344 Ball PBGA* Trays</td>
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*Pb Free Tin/Silver/Copper

Applications

- Carrier-grade VoIP Gateways
- IP-PBX and PABX
- Integrated Access Devices
- Access Servers
- CTI Applications/CompactPCI® Platforms
- H.110, H.100, ST-BUS and proprietary Backplane Applications

Description

The MT90866 Digital Switch provides switching capacities of 4,096 x 2,432 channels between backplane and local streams, 2,432 x 2,432 channels among local streams and 2,048 x 2,048 channels among backplane streams. The local connected serial inputs and outputs have 32, 64 and 128 64 kb/s channels per frame with data rates of 2.048, 4.096 and 8.192 Mb/s respectively. The backplane connected serial inputs and outputs have 128 and 256 64 kb/s channels per frame with data rates of 8.192 and 16.384 Mb/s respectively.
The MT90866 also offers a sub-rate switching configuration which allows 2-bit wide 16 kb/s or 4-bit wide 32 kb/s data channels to be switched within the device.

The device has features that are programmable on a per-stream or a per-channel basis including message mode, input delay offset, output advancement offset, direction control, and high impedance output control.

The MT90866 supports all three of the H.110 specification required clocking modes: Primary Master, Secondary Master and Slave.

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## Changes Summary

The following table captures the changes from the September 2005 issue.

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<td>Ball Signal Assignment</td>
<td>Added missing Ball signals.</td>
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<tr>
<td>11</td>
<td>Pin name: RESET</td>
<td>Worst case 600 µs instead of 100 µs is specified for the delay that must be applied before performing the first microprocessor access after the release of RESET pin.</td>
</tr>
<tr>
<td>44</td>
<td>Section 20.0</td>
<td>The 600 µs delay requirement before performing the first microprocessor access after the release of RESET pin is added in this section for completeness.</td>
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<td>80</td>
<td>Figure 40</td>
<td>Corrected 8 Mb/s stream channel to ch127</td>
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The following table captures the changes from the October 2003 issue.

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<td>37, 58</td>
<td>Section 18.2 and Table 21</td>
<td>Added description clarifying that the MTIE reset must be set when the device is in the slave mode.</td>
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<td>60</td>
<td>Table 22</td>
<td>Added MRST (bit 10) in MT90866 Mode Selection table</td>
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<tr>
<td>39, 41</td>
<td>Section 18.7 and Section 19.1</td>
<td>Deleted the intrinsic jitter descriptions in Section 18.7 and Section 19.1 and replaced them with “AC Electrical Characteristics†- Output Clock Jitter Generation (Unfiltered)” on page 76.</td>
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<td>77, 78, 80</td>
<td>“AC Electrical Characteristics† - Backplane Serial Streams with Data Rate of 8 Mb/s”, “AC Electrical Characteristics† - Backplane Serial Streams with Data Rate of 16 Mb/s” and “AC Electrical Characteristics† - Local Serial Stream Input Timing”</td>
<td>Input data sampling timings were updated for clarity purposes.</td>
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Figure 2 - 27 mm x 27 mm PBGA (JEDEC MO-151) Pinout

- A1 corner is identified by metallized markings.
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## Pin Description

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<td>V&lt;sub&gt;DD&lt;/sub&gt;</td>
<td>+3.3 Volt Power Supply.</td>
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<td>U7, U9, U10, U12,</td>
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<td>U14, U16</td>
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<tr>
<td>A2, A9, B2, H1</td>
<td>V&lt;sub&gt;DDV&lt;/sub&gt;</td>
<td>+5.0 V/+3.3 V Power Supply. If 5 V power supply is tied to these pins, STio0-31 pins will meet 5 V PCI requirements. If 3.3 V power supply is tied to these pins, STio0-31 pins will meet 3.3 V PCI requirements.</td>
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<td>V&lt;sub&gt;SS&lt;/sub&gt;</td>
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<td>F8-F13, F17, G7-G14, H2, H3, H4, H6-H15, H17, J6-J15, K6-K15, K17, L4, L6-L15, M6-M15, N4, N6-15, N17, P7-P14, P18, R1, R2, R3, R4, R8-R13, R17, U4, U6, U8, U11, U13, U15, U17, V12, V18, W12, W19, W20, Y12</td>
<td>STio0-3, STio4-7, STio8-11, STio12-15</td>
<td>Serial Input/Output Streams 0 - 15 (5 V Tolerant PCI I/Os). In H.110 mode, these pins accept serial TDM data streams at 8.192 Mb/s with 128 channels per stream. In the 16 Mb/s mode, these pins accept serial TDM data streams at 16.384 Mb/s with 256 channels per stream respectively.</td>
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### Pin Description (continued)

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<td>STio16 - 19, STio20 - 23, STio24 - 27, STio28 - 31</td>
<td><strong>Serial Input/Output Streams 16 - 31 (5 V Tolerant PCI I/Os).</strong> In H.110 mode, these pins accept serial TDM data streams at 8.192 Mb/s with 128 channels per stream. In the 16 Mb/s mode, these pins are tristated internally and should be connected to ground.</td>
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<td>C10, B10, A10, A11</td>
<td>STI0 - 3</td>
<td><strong>Serial Input Streams 0 - 3 (5 V Tolerant Inputs).</strong> In 2 Mb/s, 4 Mb/s or 8 Mb/s mode, these inputs accept data rates of 2.048, 4.096 or 8.192 Mb/s with 32, 64 or 128 channels per stream respectively. In the 2-bit and 4-bit sub-rate modes, these inputs accept a data rate of 2.048 Mb/s.</td>
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<tr>
<td>C11, B11, B12, C12</td>
<td>STI4 - 7</td>
<td><strong>Serial Input Streams 4 - 7 (5 V Tolerant Inputs).</strong> In 2 Mb/s, 4 Mb/s or 8 Mb/s mode, these inputs accept data rates of 2.048, 4.096 or 8.192 Mb/s with 32, 64 or 128 channels per stream respectively. In the 2-bit and 4-bit sub-rate modes, these inputs accept a data rate of 2.048 Mb/s.</td>
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<tr>
<td>A12, A13, B13, C13</td>
<td>STI8 - 11</td>
<td><strong>Serial Input Streams 8 - 11 (5 V Tolerant Inputs).</strong> In 2 Mb/s, 4 Mb/s or 8 Mb/s mode, these inputs accept data rates of 2.048, 4.096 or 8.192 Mb/s with 32, 64 or 128 channels per stream respectively. In the 2-bit and 4-bit sub-rate modes, these inputs accept a data rate of 2.048 Mb/s.</td>
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<tr>
<td>A14, A15, B15, C15</td>
<td>STI12 - 15</td>
<td><strong>Serial Input Streams 12 - 15 (5 V Tolerant Inputs).</strong> In 2 Mb/s, 4 Mb/s or 8 Mb/s mode, these inputs accept data rates of 2.048, 4.096 or 8.192 Mb/s with 32, 64 or 128 channels per stream respectively. In the 2-bit and 4-bit sub-rate modes, these inputs accept a data rate of 2.048 Mb/s.</td>
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<tr>
<td>A16, B16, C16, C17, B17, A17, A18, B18, A19, B19, A20, B20</td>
<td>STI16 - 27</td>
<td><strong>Serial Input Streams 16 - 27 (5 V Tolerant Inputs).</strong> In 2 Mb/s mode, these inputs accept data rates of 2.048 Mb/s with 32 channels per stream respectively. In 4 Mb/s or 8 Mb/s mode, the STI16 - 18 inputs accept data rates of 4.096 or 8.192 Mb/s with 64 or 128 channels per stream respectively. In 4 Mb/s or 8 Mb/s mode the STI19 - 27 inputs should be driven low. No sub-rate switching mode is offered for STI16-27.</td>
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<tr>
<td>D19, D20, E19, E20</td>
<td>STO0 - 3</td>
<td><strong>Serial Output Streams 0 - 3 (5 V Tolerant Tri-State Outputs).</strong> In 2 Mb/s, 4 Mb/s or 8 Mb/s mode, these outputs have data rates of 2.048, 4.096 or 8.192 Mb/s with 32, 64 or 128 channels per stream respectively. In the 2-bit and 4-bit sub-rate modes, these outputs have a data rate of 2.048 Mb/s.</td>
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<tr>
<td>F18, F19, F20, G20</td>
<td>STO4 - 7</td>
<td><strong>Serial Output Streams 4 - 7 (5 V Tolerant Tri-State Outputs).</strong> In 2 Mb/s, 4 Mb/s or 8 Mb/s mode, these outputs have data rates of 2.048, 4.096 or 8.192 Mb/s with 32, 64 or 128 channels per stream respectively. In the 2-bit and 4-bit sub-rate modes, these outputs have a data rate of 2.048 Mb/s.</td>
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<tr>
<td>G18, G19, H18, H19</td>
<td>STO8 - 11</td>
<td><strong>Serial Output Streams 8 - 11 (5 V Tolerant Tri-State Outputs).</strong> In 2 Mb/s, 4 Mb/s or 8 Mb/s mode, these outputs have data rates of 2.048, 4.096 or 8.192 Mb/s with 32, 64 or 128 channels per stream respectively. In the 2-bit and 4-bit sub-rate modes, these outputs have a data rate of 2.048 Mb/s.</td>
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<tr>
<td>J18, H20, J19, J20</td>
<td>STO12 - 15</td>
<td><strong>Serial Output Streams 12 - 15 (5 V Tolerant Tri-State Outputs).</strong> In 2 Mb/s, 4 Mb/s or 8 Mb/s mode, these outputs have data rates of 2.048, 4.096 or 8.192 Mb/s with 32, 64 or 128 channels per stream respectively. In the 2-bit and 4-bit sub-rate modes, these outputs have a data rate of 2.048 Mb/s.</td>
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### Pin Description (continued)

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<td>K18, K19, K20, L20, L18, L19, M18, M19, M20, N20, N19, N18</td>
<td>STo16 - 27</td>
<td><strong>Serial Output Streams 16 to 27 (5 V Tolerant Tri-state Outputs).</strong> In 2 Mb/s mode, these outputs have data rate of 2.048 Mb/s with 32 channels per stream. In 4 Mb/s or 8 Mb/s mode, the STo16 - 18 outputs have data rates of 4.096 Mb/s or 8.192 Mb/s with 64 or 128 channels per stream respectively; STo19 - 27 are driven low. No sub-rate switching mode is offered for STo16-27.</td>
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<tr>
<td>R18</td>
<td>ODE</td>
<td><strong>Output Drive Enable (5 V Tolerant Input).</strong> When this pin is low, STo0 to STo27, STio0 to STio31, C1M5o, C32/64o, ST_CK0, ST_CK1, ST_FPo0 and ST_FPo1 outputs are all in high-impedance state. When ODE is high all of the aforementioned pins are active.</td>
</tr>
<tr>
<td>J2</td>
<td>BCSTo</td>
<td><strong>Backplane Control Signal (Output).</strong> This pin is used for backplane external tristate controllers. When this signal is high, the corresponding output channels are in a high impedance state. BCSTo’s bit rate is 32.768 MHz.</td>
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<tr>
<td>E18</td>
<td>LCSTo</td>
<td><strong>Local Control Signal (Output).</strong> This pin is used for local external tristate control. When this signal is high, the corresponding output channels are in a high impedance state. The bit rate is 32.768 MHz.</td>
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<tr>
<td>Y13</td>
<td>C20i</td>
<td><strong>Master Clock (5 V Tolerant Input).</strong> This pin accepts a 20.000 MHz clock.</td>
</tr>
<tr>
<td>R19</td>
<td>C8_A_io</td>
<td><strong>Clock A (5 V Tolerant I/O).</strong> This is a 8.192 MHz clock with 50% duty cycle.</td>
</tr>
<tr>
<td>R20</td>
<td>FRAME_A_io</td>
<td><strong>Frame Reference A (5 V Tolerant I/O).</strong> This is a 122 ns wide, negative pulse with 125 us period.</td>
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<tr>
<td>P20</td>
<td>A_Active</td>
<td><strong>A Clock Active Indicator (5 V Tolerant Output):</strong> This pin indicates whether the C8_A_io and the FRAME_A_io pins are inputs or outputs. When Bit 13 of the DOM1 register is low, this pin drives low and the C8_A_io and FRAME_A_io output drivers are disabled. When Bit 13 of the DOM1 register is high, this pin drives high and the C8_A_io and FRAME_A_io output drivers are enabled.</td>
</tr>
<tr>
<td>T19</td>
<td>C8_B_io</td>
<td><strong>Clock B (5 V Tolerant I/O).</strong> This is a 8.192 MHz clock with 50% duty cycle.</td>
</tr>
<tr>
<td>T18</td>
<td>FRAME_B_io</td>
<td><strong>Frame Reference B (5 V Tolerant I/O).</strong> This is a 122 ns wide, negative pulse with 125 us period.</td>
</tr>
<tr>
<td>P19</td>
<td>B_Active</td>
<td><strong>B Clock Active Indicator (5 V Tolerant Output):</strong> This pin indicates whether the C8_B_io and the FRAME_B_io pins are inputs or outputs. When Bit 14 of the DOM1 register is low, this pin drives low and the C8_B_io and FRAME_B_io output drivers are disabled. When Bit 14 of the DOM1 register is high, this pin drives high and the C8_B_io and FRAME_B_io output drivers are enabled.</td>
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<tr>
<td>T20</td>
<td>FAIL_A</td>
<td><strong>A Failure (Output).</strong> When the C8_A_io or the FRAME_A_io signal fails, this signal goes to high.</td>
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<tr>
<td>U18</td>
<td>FAIL_B</td>
<td><strong>B Failure (Output).</strong> When the C8_B_io or the FRAME_B_io signal fails, this signal goes to high.</td>
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### Pin Description (continued)

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<td>U19</td>
<td>CTREF1</td>
<td><strong>CT-Bus Reference 1 (5 V Tolerant Input).</strong> This pin accepts 8 KHz, 1.544 MHz or 2.048 MHz network timing reference.</td>
</tr>
<tr>
<td>U20</td>
<td>CTREF2</td>
<td><strong>CT-Bus Reference 2 (5 V Tolerant Input).</strong> This pin accepts 8 KHz, 1.544 MHz or 2.048 MHz network timing reference.</td>
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<tr>
<td>W17, Y17, V16, W16, Y16, V15, W15, Y15</td>
<td>LREF0-7</td>
<td><strong>Local Reference (5 V Tolerant Inputs).</strong> These pins accept 8 KHz, 1.544 MHz or 2.048 MHz local timing reference.</td>
</tr>
<tr>
<td>V17</td>
<td>NREFo</td>
<td><strong>Network Reference Output (Output).</strong> Any local reference can be switched to this output. The output data rate can be either the same as the selected reference input data rate or divided to be 8 KHz.</td>
</tr>
<tr>
<td>Y20</td>
<td>PRI_LOS</td>
<td><strong>Primary Reference Lost (5 V Tolerant Input).</strong> When this signal is high, it indicates that PRIMARY REFERENCE is not valid. Combined with SEC_LOS input, this input pin is used in the External Reference Switching Mode of the DPLL.</td>
</tr>
<tr>
<td>Y19</td>
<td>SEC_LOS</td>
<td><strong>Secondary Reference Lost (5 V Tolerant Input).</strong> When this signal is high, it indicates that SECONDARY REFERENCE is not valid. Combined with the PRI_LOS input, this input pin is used in the External Reference Switching Mode of the DPLL.</td>
</tr>
<tr>
<td>W14</td>
<td>FAIL_PRI</td>
<td><strong>Primary Reference Failure (5 V Tolerant Output).</strong> This pin reflects the logic status of the PLS bit of the DPLL House Keeping Register (DHKR). When the primary reference fails, this signal goes to 1.</td>
</tr>
<tr>
<td>Y14</td>
<td>FAIL_SEC</td>
<td><strong>Secondary Reference Failure (5 V Tolerant Output).</strong> This pin reflects the logic status of the SLS bit of the DPLL House Keeping Register (DHKR). When the secondary reference fails, this signal goes to 1.</td>
</tr>
<tr>
<td>W18</td>
<td>C32/64o</td>
<td><strong>C32/64o Clock (5 V Tolerant Output).</strong> A 32.768 MHz output clock when the DPLL Clock Monitor register bit (CKM) is low. A 65.536 MHz clock when the DPLL Clock Monitor register bit (CKM) is high.</td>
</tr>
<tr>
<td>Y18</td>
<td>C1M5o</td>
<td><strong>C1.5o Clock (5 V Tolerant Output).</strong> A 1.544 MHz output clock.</td>
</tr>
<tr>
<td>V20</td>
<td>ST_FPo0</td>
<td><strong>ST-Bus Frame Pulse Output (5 V Tolerant Output).</strong> The width of this output ST-Bus frame pulse can be 244 ns, 122 ns or 61 ns. The frequency is 8 KHz.</td>
</tr>
<tr>
<td>V19</td>
<td>ST_CKo0</td>
<td><strong>ST-Bus Clock Output (5 V Tolerant Output).</strong> The frequency of this output ST-Bus clock can be 4.096 MHz, 8.192 MHz or 16.384 MHz.</td>
</tr>
<tr>
<td>W8</td>
<td>ST_FPo1</td>
<td><strong>ST-Bus Frame Pulse Output (5 V Tolerant Output).</strong> The width of this output ST-Bus frame pulse can be 244 ns, 122 ns or 61 ns. The frequency is 8 KHz.</td>
</tr>
<tr>
<td>Y8</td>
<td>ST_CKo1</td>
<td><strong>ST-Bus Clock Output (5 V Tolerant Output).</strong> The frequency of this output ST-Bus clock can be 4.096 MHz, 8.192 MHz or 16.384 MHz.</td>
</tr>
<tr>
<td>V1</td>
<td>CS</td>
<td><strong>Chip Select (5 V Tolerant Input).</strong> This active low input is used by the microprocessor to access the microport.</td>
</tr>
</tbody>
</table>
Pin Description (continued)

<table>
<thead>
<tr>
<th>PBGA Ball Number</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>W1</td>
<td>DS</td>
<td>Data Strobe (5 V Tolerant Input). This active low input works in conjunction with CS to initiate the read and write cycles.</td>
</tr>
<tr>
<td>Y1</td>
<td>R/W</td>
<td>Read/Write (5 V Tolerant Input). This input controls the direction of the data bus lines (D0 - D15) during the microprocessor access.</td>
</tr>
<tr>
<td>W4, Y3, V4, W3, Y2, V3, W2, V2, U3, U2, U1, T3, T2, T1</td>
<td>A0 - A13</td>
<td>Address 0 - 13 (5 V Tolerant Inputs). These are the address lines to the internal memories and registers.</td>
</tr>
<tr>
<td>P3, P2, P1, N2, N3, N1, M1, M2, M3, L1, L2, L3, K1, K2, K3, J3</td>
<td>D0 - D15</td>
<td>Data Bus 0 - 15 (5 V Tolerant I/Os). These pins form the 16-bit data bus of the microport.</td>
</tr>
<tr>
<td>J1</td>
<td>DTA</td>
<td>Data Transfer Acknowledge (5 V Tolerant Output). This active low output indicates that a data bus transfer is completed. A pull-up resistor is required to hold a high level.</td>
</tr>
<tr>
<td>B9</td>
<td>PCI_OE</td>
<td>PCI Output Enable (3.3 V Tolerant Input). This active low input is the control signal used to tristate the STio0 - 31 pins during hot-swapping. During normal operation this signal should be low.</td>
</tr>
<tr>
<td>W13</td>
<td>C64BYPS</td>
<td>PLL Bypass Clock Input (5 V Tolerant Input). Used for device testing. In functional mode, this input MUST be low.</td>
</tr>
<tr>
<td>V11</td>
<td>TM1</td>
<td>APLL Test Pin 1 (3.3 V Input). Use for APLL testing only. In normal operation, this input should be connected to ground.</td>
</tr>
<tr>
<td>Y10</td>
<td>TM2</td>
<td>APLL Test Pin 2 (3.3 V Input). Use for APLL testing only. In normal operation, this input should be connected to ground.</td>
</tr>
<tr>
<td>W10</td>
<td>SG1</td>
<td>APLL Test Control (3.3 V Input). Use for APLL testing only. In normal operation, this input should be connected to ground.</td>
</tr>
<tr>
<td>W11</td>
<td>AT1</td>
<td>Analog Test Access (5 V Tolerant I/O). Use for APLL testing only. No connection for normal operation.</td>
</tr>
<tr>
<td>Y11</td>
<td>DT1</td>
<td>Digital Test Access Output (5 V Tolerant Output). Use for APLL testing only. No connection for normal operation.</td>
</tr>
<tr>
<td>W5</td>
<td>TMS</td>
<td>Test Mode Select (3.3 V Input with Internal pull-up). JTAG signal that controls the state transitions of the TAP controller. This pin is pulled high by an internal pull-up when not driven.</td>
</tr>
<tr>
<td>W6</td>
<td>TDi</td>
<td>Test Serial Data In (3.3 V Input with Internal pull-up). JTAG serial test instructions and data are shifted in on this pin. This pin is pulled high by an internal pull-up when not driven.</td>
</tr>
<tr>
<td>Y4</td>
<td>TDo</td>
<td>Test Serial Data Out (3.3 V Tolerant Tri-state Output). JTAG serial data is output on this pin on the falling edge of TCK. This pin is held in high impedance state when JTAG is not enabled.</td>
</tr>
</tbody>
</table>
## Pin Description (continued)

<table>
<thead>
<tr>
<th>PBGA Ball Number</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>V6</td>
<td>TCK</td>
<td><strong>Test Clock (5 V Tolerant Input)</strong>. Provides the clock to the JTAG test logic. This pin should be low when JTAG is not enabled.</td>
</tr>
<tr>
<td>Y5</td>
<td>TRST</td>
<td><strong>Test Reset (3.3 V Input with Internal pull-up)</strong>. Asynchronously initializes the JTAG TAP Controller by putting it in the Test-Logic-Reset state. This pin should be pulled low to ensure that the MT90866 is in normal functional mode.</td>
</tr>
<tr>
<td>Y6</td>
<td>IC0</td>
<td>Leave unconnected for normal operation.</td>
</tr>
<tr>
<td>Y7</td>
<td>IC1</td>
<td>Leave unconnected for normal operation.</td>
</tr>
<tr>
<td>V7</td>
<td>IC2</td>
<td>In normal operation this pin MUST be connected to ground.</td>
</tr>
<tr>
<td>V10</td>
<td>IC3</td>
<td>Leave unconnected for normal operation.</td>
</tr>
<tr>
<td>V8</td>
<td>IC4</td>
<td>Leave unconnected for normal operation.</td>
</tr>
<tr>
<td>W7</td>
<td>IC5</td>
<td>Leave unconnected for normal operation.</td>
</tr>
<tr>
<td>V9</td>
<td>IC6</td>
<td>Leave unconnected for normal operation.</td>
</tr>
<tr>
<td>W9</td>
<td>IC7</td>
<td>Leave unconnected for normal operation.</td>
</tr>
<tr>
<td>Y9</td>
<td>IC8</td>
<td>Leave unconnected for normal operation.</td>
</tr>
</tbody>
</table>
1.0 Device Overview

The MT90866 can switch up to $4,096 \times 2,432$ channels while providing a rate conversion capability. It is designed to switch 64 kb/s PCM or $N \times 64$ kb/s data between the backplane and local switching applications. The device maintains frame integrity in data applications and minimum throughput delay for voice application on a per channel basis.

The backplane interface can operate at 8.192 Mb/s in CT-Bus mode or 16.384 Mb/s in ST-BUS mode and is arranged in 125 $\mu$s wide frames that contain 128 or 256 channels respectively. A built-in rate conversion circuit allows users to interface between backplane and local interfaces which operates at 2.048 Mb/s, 4.096 Mb/s or 8.192 Mb/s. When the device is in the local sub-rate switching mode, 2-bit 16 kb/s or 4-bit 32 kb/s data channels can be switched within the device. The local sub-rate switching mode is available in 2 Mb/s mode only.

By using Zarlink’s message mode capability, the microprocessor can access input and output time slots on a per channel basis. This feature is useful for transferring control and status information for external circuits or other TDM devices.

2.0 Functional Description

A Functional Block Diagram of the MT90866 is shown in Figure 1, “Functional Block Diagram” on page 2. It is designed to interface CT-Bus and ST-BUS serial streams from a backplane source and ST-BUS serial streams from a local source.

3.0 Frame Alignment Timing

In the ST-BUS or the CT-Bus mode, the C8_A_io or C8_B_io pin accepts an 8.192 MHz clock for the frame pulse alignment. The FRAME_A_io or FRAME_B_io is the frame pulse signal which goes low at the frame boundary for 122 ns. The frame boundary is defined by the rising edge of the C8_A_io or C8_B_io clock during the low cycle of the frame pulse. Figure 3, "CT-Bus Timing for 8 Mb/s Backplane Data Streams" on page 17 is the CT-Bus timing for the backplane 8.192 Mb/s data streams and Figure 4, "ST-BUS Timing for 16 Mb/s Backplane Data Streams" on page 18 is the ST-BUS timing for the 16.384 Mb/s backplane data stream.

![Figure 3 - CT-Bus Timing for 8 Mb/s Backplane Data Streams](image-url)
4.0 Switching Configuration

The device has two operation modes at different data rates for the backplane interface and five operation modes for the local interface. These modes can be programmed via the Device Mode Selection (DMS) register. Mode selections between the backplane and local interfaces are independent.

4.1 Backplane Interface

The backplane interface can be programmed to accept data streams of 8 Mb/s or 16 Mb/s. When H.110 mode is enabled, STio0 to STio31 have a data rate of 8.192 Mb/s. When ST-BUS mode is enabled, STio0 to STio15 have a data rate of 16.384 Mb/s. Table 1 on page 18 describes the data rates and mode selections for the backplane interface.

4.2 Local Interface

Five operation modes, 2 Mb/s, 4 Mb/s, 8 Mb/s, 2-bit sub-rate and 4-bit sub-rate switching, can be selected for the local ST-BUS interface. The local interface is divided into five groups. Group 0 contains STi/STo0-3, Group 1 contains STi/STo4-7, Group 2 contains STi/STo8-11, Group 3 contains STi/STo12-15 and Group 4 contains STi/STo16-27. Each group can be selected individually through the Device Mode Selection (DMS) register. Streams belonging to the same group have the same operation mode. For Groups 0 to 3, any one of the five operation modes can be selected. Input data streams STi0-15 and output data streams, STo0 -15 can be selected according to the group to which they belong. STi16-27 and output data streams STo16-27 belong to Group 4 and can operate in 2 Mb/s mode. In Group 4, only input data streams STi16-18 and output data streams STo16-18 can operate in 4 Mb/s and 8 Mb/s mode. When operating Group 4 at 4 Mb/s or 8 Mb/s the unused output streams, STo19-27 are driven low. No sub-rate modes are available for Group 4 data streams. See Table 2 on page 19 to Table 6 on page 20 for a description of the data rates and mode selection for the local ST-BUS interface.

<table>
<thead>
<tr>
<th>BMS bit of the DMS Register</th>
<th>Modes</th>
<th>Backplane Interface</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>8.192 Mb/s</td>
<td>STIo0 - 31</td>
</tr>
<tr>
<td>1</td>
<td>16.384 Mb/s</td>
<td>STIo0 - 15</td>
</tr>
</tbody>
</table>

Table 1 - Mode Selection for Backplane Streams
### DMS Register Bits

<table>
<thead>
<tr>
<th>LG02</th>
<th>LG01</th>
<th>LG00</th>
<th>Modes</th>
<th>Usable Streams</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>0</td>
<td>0</td>
<td>8.192 Mb/s</td>
<td>STi0 - 3, STo0 - 3</td>
</tr>
<tr>
<td>0</td>
<td>0</td>
<td>1</td>
<td>4.096 Mb/s</td>
<td></td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>0</td>
<td>2.048 Mb/s</td>
<td></td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>1</td>
<td>4-bit subrate</td>
<td></td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>0</td>
<td>2-bit subrate</td>
<td></td>
</tr>
</tbody>
</table>

**Table 2 - Mode Selection for Local STi0 - 3 and STo0 - 3 Streams, Group 0**

<table>
<thead>
<tr>
<th>LG12</th>
<th>LG11</th>
<th>LG10</th>
<th>Modes</th>
<th>Usable Streams</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>0</td>
<td>0</td>
<td>8.192 Mb/s</td>
<td>STi4 - 7, STo4 -7</td>
</tr>
<tr>
<td>0</td>
<td>0</td>
<td>1</td>
<td>4.096 Mb/s</td>
<td></td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>0</td>
<td>2.048 Mb/s</td>
<td></td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>1</td>
<td>4-bit subrate</td>
<td></td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>0</td>
<td>2-bit subrate</td>
<td></td>
</tr>
</tbody>
</table>

**Table 3 - Mode Selection for Local STi4 - 7 and STo4 - 7 Streams, Group 1**

<table>
<thead>
<tr>
<th>LG22</th>
<th>LG21</th>
<th>LG20</th>
<th>Modes</th>
<th>Usable Streams</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>0</td>
<td>0</td>
<td>8.192 Mb/s</td>
<td>STi8 - 11, STo8 - 11</td>
</tr>
<tr>
<td>0</td>
<td>0</td>
<td>1</td>
<td>4.096 Mb/s</td>
<td></td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>0</td>
<td>2.048 Mb/s</td>
<td></td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>1</td>
<td>4-bit subrate</td>
<td></td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>0</td>
<td>2-bit subrate</td>
<td></td>
</tr>
</tbody>
</table>

**Table 4 - Mode Selection for Local STi8 - 11 and STo8 - 11 Streams, Group 2**
5.0 Local Input Delay Selection

The local input delay selection allows individual local input streams to be aligned and shifted against the input frame pulse (FRAME_A_io or FRAME_B_io). This feature compensates for the variable path delays in the local interface. Such delays can occur in large centralized and distributed switching systems.

Each local input stream can have its own bit delay offset value by programming the local input bit delay selection registers (LIDR0 to LIDR9). See Table 12, "Local Input Bit Delay Registers (LIDR0 to LIDR9) Bits" on page 50, for the contents of these registers. Possible bit adjustment can range up to +7 3/4 bit periods forward with resolution of 1/4 bit period. See Table 13 on page 51 and Figure 19 on page 51 for local input delay programming.

6.0 Output Advancement Selection

The MT90866 allows users to advance individual backplane or local output streams with respect to the frame boundary. This feature is useful in compensating variable output delays caused by various output loading conditions. Each output stream can have its own advancement value programmed by the output advancement registers. The backplane output advancement registers (BOAR0 to BOAR3) are used to program the backplane output advancement. The local output advancement registers (LOAR0 to LOAR3) are used to program the local output advancement. Possible adjustment for local and backplane output data streams is 22.5 ns with a resolution of 7.5 ns. The advancement is independent of the output data rate. Table 14 on page 52 and Figure 20, "Example of Backplane Output Advancement Timing" on page 52, and Table 15 on page 53 and Figure 21, "Local Output Advancement Timing" on page 53 describe the details of the output advancement programming for the backplane and local interfaces respectively.
7.0 Local Output Timing Considerations

The output data of the MT90866's local side is slightly advanced with respect to the frame and bit boundary as defined by the local output clocks and frame pulses (ST_FPo0, ST_CKo0, ST_FPo1, ST_CKo1). The advancement is in the range of 5 ns to 17 ns. Despite this advancement, the MT90866 will operate within the parameters specified in the datasheet because input data are usually sampled at the 3/4 or 1/2 point of the bit cell. However, the user should be cautious when introducing additional delay to the clock signals only (e.g., by passing them through glue logic, FPGA, or CPLD), which will introduce a few nanoseconds of delay relative to the data. If the clock signal is delayed, data will be advanced from the receiver device's point of view. This may cause errors in sampling the data. Using an example where a 3/4 sampling point is used, there is about 30 ns from the sampling point to the end of the bit cell. With a worst-case of 17 ns advancement, the timing margin will be approximately 13 ns. Any additional delays applied to the local output clocks (ST_CKo0 and ST_CKo1) must not exceed 13 ns minus the hold time of the receiving device. Delays applied to both clocks and data equally will not impact the device operation.

8.0 Memory Block Programming

The MT90866 block programming mode (BPM) register provides users with the capability of initializing the local and backplane connection memories in two frames. The local connection memory is partitioned into high and low parts. Bit 13 - bit 15 of every backplane connection memory location will be programmed with the pattern stored in bit 6 - bit 8 of the BPM register. Bit 13 - bit 15 of every local connection memory low location will be programmed with the pattern stored in bits 3 to 5 of the BPM register. The other bit positions of the backplane connection memory, the local low connection memory and all bits of the local high connection memory are loaded with zeros. See Figure 5, "Block Programming Data in the Connection Memories" on page 22 for the connection memory contents when the device is in block programming mode.

The block programming mode is enabled by setting the memory block program (MBP) bit of the Control register to high. After the block programming enable (BPE) bit of the BPM register is set to high, the block programming data will be loaded into bits 13 to 15 of every backplane connection memory location and bits 13 to 15 of every local connection memory low location. The other connection memory bits are loaded with zeros. When the memory block programming is completed, the device resets the BPE bit to low. See Table 11 on page 49 for the bit assignment of the BPM register.

9.0 Delay Through the MT90866

The switching of information from the input serial streams to the output serial streams results in a throughput delay. The device can be programmed to perform time slot interchange functions with different throughput delay capabilities on a per-channel basis. For voice applications it is recommended to select variable throughput delay to ensure minimum delay between input and output data. In wideband data applications it is recommended to select constant throughput delay to maintain the frame integrity of the information through the switch.

The delay through the device varies according to the type of throughput delay selected in the BTM2 - BTM0 bits of the backplane connection memory or LTM0 - LTM2 bits of the local connection memory as described in Table 25 on page 63 and Table 29 on page 65, respectively.

9.1 Variable Delay Mode

The delay in this mode is dependent only on the combination of source and destination channels and is independent of input and output streams. The minimum delays achievable in the MT90866 device are 3-channel delay, 5-channel delay, and 10-channel delay for the 2 MB/s, 4 MB/s, and 8 MB/s respectively. The maximum delay is one frame plus three channels, one frame plus five channels, and one frame plus ten channels for the 2 Mb/s, 4 Mb/s and 8 Mb/s modes respectively.

For the backplane interface, the variable delay mode can be programmed through the backplane connection memory bits, BTM2 - BTM0. When BTM2 - BTM0 are programmed to "000", it is a per-channel variable delay from
local input to the backplane output. When BTM2 - BTM0 are set to “010”, it is a per-channel variable delay from backplane input to backplane output.

For the local interface, the variable delay mode can be programmed through the local connection memory low bits, LTM2 - LTM0. When LTM2 - LTM0 is programmed to ”000”, it is a per-channel variable delay from local input to local output. When LTM2 - LTM0 is set to ”010”, it is a per-channel variable delay from backplane input to local output.

9.2 Constant Delay Mode

In this mode, a multiple data memory buffer is used to maintain frame integrity in all switching configurations by using three pages of Data Memory where a channel written in any of the buffers during frame N is always read out during frame N+2.

For the backplane interface, when BTM2 - BTM0 is programmed to ”001”, it is a per-channel constant delay mode from local input to backplane output. When BTM2 - BTM0 is programmed to ”011”, it is a per-channel constant delay from backplane input to backplane output.

For the local interface, when LTM2 - LTM0 is programmed to ”001”, it is a per-channel constant delay mode from local input to local output. When LTM2 - LTM0 is set to ”011”, it is a per-channel constant delay mode from backplane input to local output.

10.0 Microprocessor Interface

The MT90866 provides a parallel microprocessor interface for non-multiplexed bus structures. This interface is compatible with Motorola non-multiplexed bus structure. The required microprocessor signals are the 16-bit data bus (D15-D0), 14-bit address bus (A13-A0) and 4 control lines (CS, DS, R/W and DTA). See Figure 44, ”Motorola Non-Multiplexed Bus Timing” on page 83 for the Motorola non-multiplexed bus timing.

The MT90866 microprocessor port provides access to the internal registers, the connection and data memories. All locations provide read/write access except for the Local and Backplane Bit Error Rate registers (LBERR and BBERR) and Data Memory which can only be read by the users.

10.1 DTA Data Transfer Acknowledgment Pin

The DTA pin of the microprocessor is driven LOW by internal logic to indicate that a data bus transfer is completed. When the bus cycle ends, this pin switches to the high impedance state. An external pull-up of between 1 KΩ and 10 KΩ is required at this output.
11.0 Address Mapping of Memories and Registers

The address bus on the microprocessor interface selects the internal registers and memories of the MT90866. If the address bit A13 is low, then the registers are addressed by A12 to A0 as shown in Table 7 on page 23.

<table>
<thead>
<tr>
<th>A13 - A0</th>
<th>Location</th>
</tr>
</thead>
<tbody>
<tr>
<td>0000H</td>
<td>Control Register, CR</td>
</tr>
<tr>
<td>0001H</td>
<td>Device Mode Selection Register, DMS</td>
</tr>
<tr>
<td>0002H</td>
<td>Block Programming Mode Register, BPM</td>
</tr>
<tr>
<td>0003H</td>
<td>Reserved</td>
</tr>
<tr>
<td>0004H</td>
<td>Local Input Bit Delay Register 0, LIDR0</td>
</tr>
<tr>
<td>0005H</td>
<td>Local Input Bit Delay Register 0, LIDR1</td>
</tr>
<tr>
<td>0006H</td>
<td>Local Input Bit Delay Register 2, LIDR2</td>
</tr>
<tr>
<td>0007H</td>
<td>Local Input Bit Delay Register 3, LIDR3</td>
</tr>
<tr>
<td>0008H</td>
<td>Local Input Bit Delay Register 4, LIDR4</td>
</tr>
<tr>
<td>0009H</td>
<td>Local Input Bit Delay Register 5, LIDR5</td>
</tr>
<tr>
<td>000AH</td>
<td>Local Input Bit Delay Register 6, LIDR6</td>
</tr>
<tr>
<td>000BH</td>
<td>Local Input Bit Delay Register 7, LIDR7</td>
</tr>
<tr>
<td>000CH</td>
<td>Local Input Bit Delay Register 8, LIDR8</td>
</tr>
<tr>
<td>000DH</td>
<td>Local Input Bit Delay Register 9, LIDR9</td>
</tr>
<tr>
<td>000EH to 001BH</td>
<td>Reserved</td>
</tr>
<tr>
<td>001CH</td>
<td>Backplane Output Advancement Register 0, BOAR0</td>
</tr>
<tr>
<td>001DH</td>
<td>Backplane Output Advancement Register 1, BOAR1</td>
</tr>
<tr>
<td>001EH</td>
<td>Backplane Output Advancement Register 2, BOAR2</td>
</tr>
<tr>
<td>001FH</td>
<td>Backplane Output Advancement Register 3, BOAR3</td>
</tr>
<tr>
<td>0020H</td>
<td>Local Output Advancement Register 0, LOAR0</td>
</tr>
<tr>
<td>0021H</td>
<td>Local Output Advancement Register 1, LOAR1</td>
</tr>
<tr>
<td>0022H</td>
<td>Local Output Advancement Register 2, LOAR2</td>
</tr>
<tr>
<td>0023H</td>
<td>Local Output Advancement Register 3, LOAR3</td>
</tr>
<tr>
<td>0024H to 0026H</td>
<td>Reserved</td>
</tr>
<tr>
<td>0027H</td>
<td>Local BER Input Selection Register, LBIS</td>
</tr>
<tr>
<td>0028H</td>
<td>Local BER Register, LBERR</td>
</tr>
<tr>
<td>0029H</td>
<td>Backplane BER Input Selection Register, BBIS</td>
</tr>
<tr>
<td>002AH</td>
<td>Backplane BER Register, BBERR</td>
</tr>
<tr>
<td>002BH</td>
<td>DPLL Operation Mode Register 1, DOM1</td>
</tr>
</tbody>
</table>

Table 7 - Address Map For Internal Registers (A13 = 0)
If A13 is high, the remaining address input lines are used to select the data and connection memory positions corresponding to the serial input or output data streams as shown in Table 8 on page 25.

The Control register (CR), the Device Mode Selection register (DMS) and the Block Programming Mode register (BPM) control all the major functions of the device. The DMS and BPM should be programmed immediately after system power up to establish the desired switching configuration as explained in the Frame Alignment Timing and Switching Configurations sections. The Control register is used to select Data or Connection Memory for microport operations, ST-BUS output frame and clock modes, and to set Memory Block Programing and Bit Error Rate Testing.

The Control register (CR) consists of the memory block programming bit (MBP) and the memory select bits (MS2-0). The memory block programming bit allows users to program the entire connection memory in two frames (see Memory Block Programming section). The memory select bits control the selection of the connection memories or the data memories. See Table 9 on page 46 for content of the Control register.

The DMS register consists of the backplane and the local mode selection bits (BMS, LG41 - LG40, LG32 - LG30, LG22 - LG20, LG12 - LG10 and LG02 - LG00) that are used to enable various switching modes for the backplane and the local interfaces respectively. See Table 10 on page 47 for the content of the DMS register.

The BPM register consists of the block programming data bits (LBPD2-0 and BBPD2-0) and the block programming enable bit (BPE). The block programming enable bit allows users to program the entire backplane and local connection memories in two frames (see Memory Block Programming section). If the ODE pin is low, the backplane CT-Bus is in input mode and the local output drivers are in high impedance state. If the ODE pin is high, all the backplane CT-Bus and local ST-BUS output drivers are controlled on a per channel basis by backplane and local connection memories, respectively. By programming BTM2 through BTM0 bits to “110” in the backplane connection memory, the user can control the per-channel input on the backplane interface. For the local interface, users can program LTM2 -0 bits to “110” in the local connection memory to control the per-channel high impedance output on the local ST-BUS. See Table 11 on page 49 for the content of the BPM register.

<table>
<thead>
<tr>
<th>A13 - A0</th>
<th>Location</th>
</tr>
</thead>
<tbody>
<tr>
<td>002C_H</td>
<td>DPLL Operation Mode Register 2, DOM2</td>
</tr>
<tr>
<td>002D_H</td>
<td>DPLL Output Adjustment Register, DPOA</td>
</tr>
<tr>
<td>002E_H</td>
<td>DPLL House Keeping Register, DHKR</td>
</tr>
</tbody>
</table>

Table 7 - Address Map For Internal Registers (A13 = 0) (continued)
12.0 Backplane Connection Memory

The backplane connection memory controls the switching configuration of the backplane interface. Locations in the backplane connection memory are associated with particular STio streams.

The BTM2 - 0 bits of each backplane connection memory allows the per-channel selection for the message or the connection mode, the constant or the variable delay mode, the high impedance control of the STio driver or the bit error test enable. See Table 25 on page 63 for the content per-channel control function.

In the switching mode, the contents of the backplane connection memory stream address bits (BSAB4-0) and channel address bits (BCAB7-0) define the source information (stream and channel) of the time slot that will be switched to the backplane STio streams. During the message mode, only the lower 8 bits (8 least significant bits) of the backplane connection memory will be transferred to the STio pins.

13.0 Local Connection Memory

The local connection memory controls the local interface switching configuration. Local connection memory is split into a high and a low part. Locations in the local connection memory are associated with particular STio output streams.

The LTM2 - 0 bits of each local connection memory low allows the per-channel selection for the message or the connection mode, the constant or the variable delay mode, the high impedance control of the STio driver or the bit error test enable. See Table 29 on page 65 for the content per-channel control function.

In the switching mode, the contents of the local connection memory low stream address bits (LSAB4-0) and the channel address bits (LCAB7-0) of the local connection memory defines the source information (stream and
channel) of the time slot that will be switched to the local STo streams. During the message mode, only the lower 8 bits (8 least significant bits) of the local connection memory low bits are transferred to the STo pins.

In the sub-rate switching mode, although the output channels are divided up into 2 or 4-bit channels, the input streams still have 8-bit channel boundaries. Therefore, it is necessary to indicate which bits in the input 8-bit channel will be switched out to the 2 or 4-bit channel. When 2-bit or 4-bit sub-rate switching is enabled, the LSRS1-0 bits in the local connection memory high define which bit positions contains the sub-rate data.

14.0  Bit Error Rate Test

The MT90866 offers users a Bit Error Rate (BER) test feature for the backplane and the local interfaces. The circuitry of the BER test consists of a transmitter and a receiver on both interfaces that can transmit and receive the BER patterns independently. The transmitter can output a pseudo random patterns of the form $2^{15} - 1$ to any channel and any stream within a frame time. For the test, users can program the output channel and stream through the backplane or local connection memory and the input channel and stream using Local or Backplane BER Input Selection (BIS) registers. See Table 16 on page 54 and Table 18 on page 54 for the LBIS and the BBIS registers contents, respectively.

The receiver receives the BER pattern and does an internal BER pattern comparison. For backplane interface, the comparison result is stored in the Backplane BER register (BBERR). For local interface, the result is stored in the Local BER register (LBERR).

15.0  External Tristate Control

The MT90866 has the flexibility to provide users with the choice of external per-channel tristate control. Two control signals are provided. For the backplane interface, it is the BCSTo output. For the local interface, it is the LCSTo output. Each control signal has a data rate of 32.768 Mb/s with 4,096 control bits per frame. Each bit position corresponds to a specific output stream and channel location. When the control bit is high, the corresponding output channel is in the high impedance state, whereas when the control bit is low, the corresponding output channel has active output data.

15.1  BCSTo Control Stream

When the STIo0-31 streams are in the 8 Mb/s mode, the STIo0_Ch0 control bit of the BCSTo stream is advanced by thirty-six C32/64o 32.768 Mb/s clock cycles from the backplane frame boundary. See Figure 6, "Backplane Control (BCSTo) Timing when the STIo data rate is 8 Mb/s" on page 26 for the BCSTo control bit pattern.

When the STIo0-15 streams are in the 16 Mb/s mode, the STIo0_Ch0 control bit of the BCSTo is advanced by thirty-six C32/64o 32.768 Mb/s clock cycles from the backplane frame boundary. See Figure 7, "Backplane Control (BCSTo) Timing when the STIo data rate is 16 Mb/s" on page 27 for the BCSTo control bit pattern.
Figure 7 - Backplane Control (BCSTo) Timing when the STio data rate is 16 Mb/s

15.2 LCSTo Control Stream

The LCSTo control bits are partitioned into 128 time slots, Slots 0 to 127. Each slot has 32 bits. Dummy bits represent logic levels which should be ignored by the users. The first control bit in Slot 0 is advanced by thirty-two C32/64o 32.768 Mb/s clock cycles from the frame boundary. See Figure 8, "Local Control (LCSTo) Timing when STo0-18 are operated at 8 Mb/s" on page 28 for the partition of the time slots and the frame alignment details.

When the STo0-18 streams are operated at 8 Mb/s, Slots 0 to 127 are used to represent the control bits for Channels 0 to 127 of the 8 Mb/s streams. STo19-17 are driven low in this configuration. See Figure 8, "Local Control (LCSTo) Timing when STo0-18 are operated at 8 Mb/s" on page 28 for the LCSTo control bit pattern.

When the STo0-18 streams are operated at 4 Mb/s, Slots 2N (where N = 0 to 63) have the control bit pattern but Slots 2N+1 have dummy bits which should be ignored by the user. STo19-17 are driven low in this configuration. See Figure 9, "Local Control (LCSTo) Timing when STo0-18 are operated at 4 Mb/s" on page 29 for the LCSTo control bit pattern.

When the STo0-27 streams are operated at 2 Mb/s, Slots 4N (where N = 0 to 31) have the control bit pattern, but Slots 4N+1, 4N+2 and 4N+3 have dummy bits. See Figure 10, "Local Control (LCSTo) Timing when all STo0-27 are operated at 2 Mb/s" on page 30 for the LCSTo control bit pattern.

When the STo streams are programmed with various data rates as described in Table 6 on page 20, the available control bit positions in every time slot is associated with the corresponding output stream channels which operate at various data rates. Figure 11, "Example of Local Control (LCSTo) Timing when the Local Streams have Different Data Rates" on page 31 gives an example when STo0-3, 4-7, 8-11, 12-15, 16-27 are programmed to operate at 8 Mb/s, 4 Mb/s, 8 Mb/s, 4 Mb/s and 2 Mb/s respectively.
Figure 8 - Local Control (LCSTo) Timing when St0-18 are operated at 8 Mb/s
Figure 9 - Local Control (LCSTo) Timing when STo0-18 are operated at 4 Mb/s
Figure 10 - Local Control (LCSTo) Timing when all STo0-27 are operated at 2 Mb/s
For this drawing, we assume that LSTo0-3, 4-7, 8-11, 12-15, 16-27 have data rates of 8Mb/s, 4Mb/s, 8Mb/s, 4Mb/s and 2Mb/s respectively.

This drawing is used to illustrate the LCSTo control bit format with a specific data rate combination from different local data streams.

For this drawing, we assume that LSTo0-3, 4-7, 8-11, 12-15, 16-27 have data rates of 8Mb/s, 4Mb/s, 8Mb/s, 4Mb/s and 2Mb/s respectively.

**Figure 11 - Example of Local Control (LCSTo) Timing when the Local Streams have Different Data Rates**
16.0 DPLL

The Digital Phase Locked Loop (DPLL) accepts selectable 1.544 MHz, 2.048 MHz, or 8 kHz input reference signals. It accepts reference inputs from independent sources and provides bit-error-free reference switching. The DPLL meets phase slope and MTIE requirements defined by the Telcordia GR-1244-CORE standard.

The DPLL also provides the timing for the rest of the MT90866 Digital Switch, generating several network clocks with the appropriate quality. Clocks are synchronized to one of two input reference clocks and meet the requirements of the H.110 clock specification.

The master clock (CLK80M) for the DPLL is provided by the Analog Phase Locked Loop (APLL) from the MT90866 master clock input pin C20i. Since the APLL output is “locked” to the input, the accuracy of CLK80M clock is equal to the accuracy of C20i.

16.1 MT90866 Modes of Operation

The DPLL, and consequently the MT90866, can, as required by the H.110 standard, operate in three different modes: Primary Master, Secondary Master and Slave. See Figure 12, "Typical Timing Control Configuration" on page 32.

To configure the DPLL, there are two Operation Mode registers: DOM1 and DOM2. See Table 20 on page 55 and Table 21, "DPLL Operation Mode (DOM2) Register Bits" on page 58 for the contents of these registers.

In all modes the MT90866 monitors both the “A Clocks” (C8_A_io and FRAME_A_io) and the “B Clocks” (C8_B_io and FRAME_B_io). The Fail_A and the Fail_B signals indicate the quality of the “A Clocks” and “B Clocks” respectively.

![Figure 12 - Typical Timing Control Configuration](image)

16.1.1 Primary Master Mode

In the Primary Master Mode, the MT90866 drives the “A Clocks” (C8_A_io and FRAME_A_io), by locking to the primary reference (PRI_REF). The PRI_REF can be provided by one of the locally derived network reference sources (LREF0-7), or the CTREF1 input or the CTREF2 input. In this mode the MT90866 has the ability to monitor the primary reference. If the primary reference becomes unreliable, the device continues driving “A Clocks” in stable Holdover Mode until it makes a Stratum 4 Enhanced compatible switch to the secondary reference (SEC_REF) for its network timing. The secondary reference can be provided by one of the local network references (LREF0-7), the CTREF1 or the CTREF2.
If the primary reference comes back or recovers, the MT90866 makes a **Stratum 4 Enhanced** compatible switch back to the original primary reference and the system returns to normal operation state.

If necessary, the MT90866 can be prevented from switching back to the original primary reference by programming the RPS bit in DOM1 register to give preference to the secondary reference.

While in the Primary Master mode, the MT90866 attenuates jitter and wander above 1.52 Hz from the selected input reference clock and generates all output clocks according to the DPLL jitter transfer function diagram on Figure 17, "DPLL Jitter Transfer Function Diagram - wide range of frequencies" on page 42 and Figure 18, "Detailed DPLL Jitter Transfer Function Diagram" on page 43.

For the Primary Master mode selection, see Table 22, "MT90866 Mode Selection - By Programming DOM1 and DOM2 Registers" on page 60.

### 16.1.2 Secondary Master Mode

In the Secondary Master Mode, the MT90866 drives the “B Clocks” (C8_B_io and FRAME_B_io), by locking to the “A Clocks”. As required by the H.110 standard, the “B Clocks” are edge-synchronous with the “A Clocks”, as long as jitter on the “A Clocks” meets Telcordia GR-1244-CORE specifications.

If the “A Clocks” become unreliable, system software is notified and the MT90866 continues driving the “B Clocks” in stable Holdover Mode until it makes a **Stratum 4 Enhanced** compatible switch to the secondary reference (SEC_REF) for its network timing. The secondary reference can be the local network reference (LREF0-7), the CTREF1 or the CTREF2. If the “A Clocks” can not recover, the designated secondary master can be promoted to primary master by system software. This promotion will cause the “B Clocks” to assume the role of the “A Clocks”.

For the Secondary Master mode selection, see Table 22, "MT90866 Mode Selection - By Programming DOM1 and DOM2 Registers" on page 60.

### 16.1.3 Slave Mode

In the Slave Mode, the MT90866 is phase locked to the “A Clocks”. If the “A Clocks” become unreliable, the device goes to stable Holdover Mode until it makes a **Stratum 4 Enhanced** compatible switch to the “B Clocks”. The MT90866 will perform all required functionality as long as the “A Clocks” and the “B Clocks” conform to the Telcordia GR-1244-CORE jitter specifications.

In addition, the device can be used to generate a CT reference (CT_REF1 or CT_REF2) from its network references, LREF0-7.

While the device is in Slave Mode and the “A Clocks” or the “B Clocks” do not recover, then the designated slave can be promoted to secondary master by system software. In that case, the network reference can be used as the secondary reference.

Table 22 on page 60 shows how to program the DOM1 and DOM2 registers to enable the Slave mode of the MT90866.
17.0 DPLL Functional Description

The DPLL accepts two simultaneous reference input signals and operates on their rising edges. Either the primary reference (PRI_REF) signal or the secondary reference (SEC_REF) signal can be selected to be the reference signal (REF) to the PLL circuit. The appropriate frequency mode input (either FREQ_MOD_PRI or FREQ_MOD_SEC) is selected to be the input of the PLL Circuit. The selection is done by the State Machine Circuit based on the current state.

The FREQ_MOD_PRI and the FREQ_MOD_SEC are 2-bit wide inputs which reflect the value in the FP1-0 and FS1-0 bits of the DOM1 register. The primary and the secondary references operate independently from each other and can have different frequencies. Switching the reference from one frequency to another does not require the device reset to be applied. Table 20 on page 55 shows input frequency selection for the primary and secondary reference respectively.

Figure 13 - DPLL Functional Block Diagram

17.1 Reference Select and Frequency Mode MUX Circuits

The DPLL accepts two simultaneous reference input signals and operates on their rising edges. Either the primary reference (PRI_REF) signal or the secondary reference (SEC_REF) signal can be selected to be the reference signal (REF) to the PLL circuit. The appropriate frequency mode input (either FREQ_MOD_PRI or FREQ_MOD_SEC) is selected to be the input of the PLL Circuit. The selection is done by the State Machine Circuit based on the current state.

The FREQ_MOD_PRI and the FREQ_MOD_SEC are 2-bit wide inputs which reflect the value in the FP1-0 and FS1-0 bits of the DOM1 register. The primary and the secondary references operate independently from each other and can have different frequencies. Switching the reference from one frequency to another does not require the device reset to be applied. Table 20 on page 55 shows input frequency selection for the primary and secondary reference respectively.
17.2 PRI and SEC MUX Circuits

The DPLL has four different modes to handle reference failure. These modes are selected by the FDM0 and FDM1 bits of the DOM2 Register. If FDM1-0 is '10' then the Primary reference is always used regardless of failures. If FDM1-0 is '11' then the Secondary reference is always used regardless of failures. Otherwise the DPLL operates in one of two failure detection modes: Autodetect or Manual detection mode. When the FDM0 bit is set to low in the DOM2 register '00', the DPLL is in the Autodetect Mode. In this mode, the outputs from the Reference Monitor Circuits LOS_PRI and LOS_SEC are used by the State Machine Circuit. When the FDM0 bit is set to high and FDM1 bit is set to low '01', the DPLL is in the Manual Detection Mode and the LOS_PRI and LOS_SEC signals are selected from the PRI_LOS and SEC_LOS input pins to be used by the State Machine Circuit. See Table 21 on page 58 for selection of the Failure Detection Modes.

17.3 Frame Select MUX

When the “A Clocks” or the “B Clocks” are selected as the input reference, an 8.192 MHz clock (either C8_A_io or C8_B_io) is provided to be the input reference to the PLL circuit (REF). Because the output frame pulse (CT_FRAME) must be aligned with the selected input frame pulse, the appropriate frame pulse (either FRAME_A_io or FRAME_B_io) is selected in the Frame Select MUX circuit to be the input of the PLL circuit (FRAME).

17.4 CT Clock and Frame Monitor Circuits

The CT Clock and Frame Monitor circuits check the period of the C8_A_io and the C8_B_io clocks and the FRAME_A_io and FRAME_B_io frame pulses. According to the H.110 specification, the C8 period is 122 ns with a tolerance of +/- 35 ns measured between rising edges. If C8 falls outside the range of [87 ns,157 ns], the clock is rejected and the fail signal (FAIL_A or FAIL_B) becomes high. The Frame pulse period is measured with respect to the C8 clock. The frame pulse period must have exactly 1024 C8 cycles. Otherwise, the fail signal (FAIL_A or FAIL_B) becomes high. When the CT BUS clock and frame pulse signals return to normal, the FAIL_A or FAIL_B signal returns to logic low.

17.5 Reference Monitor Circuits

There are two Reference Monitor Circuits: one for the primary reference (PRI_REF) and one for the secondary reference (SEC_REF). These two circuits monitor the selected input reference signals and detect failures by setting up the appropriate fail outputs (FAIL_PRI and FAIL_SEC). These fail signals are used in the Autodetect mode as the LOS_PRI and LOS_SEC signals to indicate when the reference has failed. The method of generating a failure depends on the selected reference.

When the selected reference frequency is 8.192 MHz (“A Clocks” or “B Clocks”), the fail signals are passed through from the CT Clock and Frame Monitor circuit outputs FAIL_A and FAIL_B, and used directly as FAIL_PRI and FAIL_SEC, accordingly.

For all other reference frequencies (8 kHz, 1.544 MHz and 2.048 MHz), the following checks are performed:

- For all references, the “minimum 90 ns” check is done. This is required by the H.110 specifications - both low level and high level of the reference must last for minimum 90 ns each.
- The “period in the specified range” check is done for all references. The length of the period of the selected input reference is checked if it is in the specified range. For the E1 (2.048 MHz clock) or the T1 (1.544 MHz clock) reference, the period of the clock can vary within the range of 1 +/- 1/4 of the defined clock period which is 488 ns for the E1 clock and 648 ns for T1 clock. For the 8 KHz reference, the variation is from 1 +/- 1/32 period.
- If the selected reference is E1 or T1, “64 periods in the specified range” check is done. The selected reference is observed for a long period (64 reference clock cycles) and checked if it is within the specified range - from 62 to 66 clock periods.
These reference signal verifications include a complete loss or a large frequency shift of the selected reference signal. When the reference signal returns to normal, the LOS_PRI and LOS_SEC signals will return to logic low.

17.6 State Machine Circuit

The State Machine handles the reference selection. Depending on REF_SEL and LOS signals (selection between FAIL_PRI and PRI_LOS and between FAIL_SEC and SEC_LOS), the state machine selects PRI_REF or SEC_REF as the current input reference and dictates the PLL Circuit mode: Normal or Holdover Mode. In the Normal Mode, the DPLL output clocks are locked to the selected input reference (PRI_REF or SEC_REF). In the Holdover Mode, the DPLL clocks retain the phase and frequency values they had 32 to 64 ms prior to moving from the Normal to the Holdover Mode. When going from the Holdover to the Normal Mode, the State Machine activates the MTIE circuit and goes through the states MTIE PRI or MTIE SEC to prevent a phase shift of the output clocks during the DPLL reference switch (from PRI_REF to SEC_REF and vice versa). The state diagram is given in Figure 14, "State Machine Diagram" on page 36.

![State Machine Diagram](image_url)

**Figure 14 - State Machine Diagram**

18.0 Phase Locked Loop (PLL) Circuit

As shown in Figure 15, "Block Diagram of the PLL Module" on page 37, the PLL module consists of a Skew Control, Maximum Time Interval Error (MTIE), Phase Detector, Phase Offset Adder, Phase Slope Limiter, Loop Filter, Digitally Controlled Oscillator (DCO), Divider and Frequency Select MUX modules.
18.1 Skew Control

The circuit delays a selected reference input with a tapped delay line with seven taps - see Figure 16, "Skew Control Circuit Diagram" on page 37. The maximum delay of the per unit delay element is factored at intervals of 3.5 ns. The tap is selected by the SKEW_CONTROL bus which is programmed by the SKC2-SKC0 bits of the DPLL Output Adjustment (DPOA) register. The skew of this input will result in a static phase offset which varies from 0 to 7 steps of the maximum delay per unit delay element, between the input and the outputs of the DPLL.

18.2 Maximum Time Interval Error (MTIE)

The MTIE circuit prevents any significant change in the output clock phase during a reference switch. Because the input references can have any relationship between their phases and the output follows the selected input reference, any switch from one reference to another could cause a large phase jump in the output clock if such a circuit did not exist. This large phase jump could cause significant data loss. The MTIE circuit keeps the phase difference between the output clock of the DPLL and the input reference the same as if the reference switch had not taken place.

The MTIE circuit has two modes:

- Measuring mode - the circuit measures the phase difference between the new reference from the Skew Control circuit and the feedback signal (FEEDBACK) from the Frequency Select MUX circuit. This mode is active during the movement of the DPLL from the Holdover to the Normal Mode, and is set by the MTIE_START signal of the State machine module. The measured value is stored into a counter and used in the Delay mode. When the measurement process is done, the State Machine module is notified by generating the MTIE_DONE signal, allowing it to go to the Normal Mode.
• Delay mode - after the rising edge of the new reference clock from the Skew Control circuit, the MTIE circuit uses the measured value to generate the virtual reference pulse (REF_VIR) to the Phase Detector circuit. While the DPLL is in the Normal Mode, the MTIE Circuit is in Delay mode. It keeps the phase difference between the output signals of the DPLL and selected input reference as the previous output signal would have been if the reference switch had not taken place.

During a reference switch, the State Machine module first changes the mode of the DPLL from the Normal to the Holdover Mode. In the Holdover Mode, the DPLL no longer uses the virtual reference signal, but generates very accurate outputs using storage techniques.

Because the input reference coming from the Skew Control circuit is asynchronous to the sampling clock used in the MTIE circuit, a phase error may exist between the selected input reference signal and the output signal of the DPLL. In the worst case, the Maximum Time Interval Error (MTIE) is one period of the internally used clock cycle (65.536 MHz if the selected reference frequency is 8 kHz, 2.048 MHz and 8.192 MHz, and 49.408 MHz when the selected reference frequency is 1.544 MHz). This phase error is a function of the difference in phase between the two input reference signals during reference rearrangements. Each time a reference switch is made, the delay between the input signal and the output signal can change. The value of this delay is the accumulation of the error measured during each reference switch. After many switches from one reference to another, the delay between the selected input reference and the DPLL output clocks can become unacceptably large. The user should provide MTIE reset (set MRST bit in the DOM2 register to high) causing output clocks to align to the nearest edge of the selected input reference. It is recommended that the MTIE is reset after multiple reference switchings and the device falls back to its initial reference. The MTIE MUST be kept in the reset mode when the ZL50031 is operating in the slave mode.

18.3 Phase Detector

The Phase Detector circuit compares the virtual reference signal from the MTIE Circuit (REF_VIR) with the feedback signal from the Frequency Select MUX circuit (FEEDBACK) with respect to their rising edges, and provides an error signal corresponding to the phase difference between the two. This error signal is passed to the Phase Offset Adder Circuit. The Frequency Select MUX allows the proper feedback signal to be selected (e.g., 8 kHz, 1.544 MHz, 2.048 MHz or 8.192 MHz).

18.4 Phase Offset Adder

The Phase Offset Adder Circuit adds the PHASE_OFFSET word (bits POS6-POS0 of the DPLL Output Adjustment register - see Table 23 on page 61) to the error signal from the Phase Detector circuit to create the final phase error. This value is passed to the Phase Slope Limiter circuit. The PHASE_OFFSET word can be positive or negative. Since the PLL will stabilize to a situation where the average of the sum of the phase offset word and the phase detector output is zero, a nonzero value in the input of the Phase Offset Adder circuit will result in a static phase offset between the input and output signals of the DPLL.

If the selected input reference of the DPLL is either 8 KHz or 2.048 MHz, the step size in this static phase offset is 15.2 ns. With a 7-bit 2’s complement value, the static phase offset can be set between -0.96 µs and +0.97 µs. If the selected input reference of the DPLL is 1.544 MHz, the maximum phase offset is between -1.27 µs and 1.29 µs with a resolution of 20.2 ns.

Together with the Skew Control bits (SKC2-SKC0), users can program a static phase offset between -960 ns and +990 ns if the selected input reference of the DPLL is either 8 kHz or 2.048 MHz. If the selected reference is 1.544 MHz, the programmable phase offset is between -1.27 µs and 1.30 µs. For the programmable ranges mentioned above, the resolution is 1.9 ns per step. See Table 23 on page 61 for the content of the DPOA register.

When the selected input reference frequency of the DPLL is 8.192 MHz ("A Clocks" or "B Clocks" are selected as the reference), the Phase Offset Adder is bypassed. The output of the Phase Detector circuit is connected directly to the input of the Phase Slope Limiter circuit. When an 8.192 MHz clock (C8_A_io or C8_B_io) is used as the reference in the Secondary Master or the Slave mode, the H.110 standard requires the output clock to always follow the input reference on an edge-to-edge basis, so the static phase offset is not required.
18.5 Phase Slope Limiter

The limiter receives the error signal from the Phase Offset Adder circuit and ensures that the DPLL responds to all input transient conditions with a maximum output phase slope of 7.6 ns per 125 us. Because of this slope, the MT90866 is within the maximum phase slope of 81 ns per 1.326 ms specified by the Telcordia GR-1244-CORE standard.

The frequency stability of the Holdover Mode is ±0.07 ppm, which translates to a worst case 49 frame (125 μs) slips in 24 hours. This is better than the Telcordia GR-1244-CORE Stratum 3 requirement of ±0.37 ppm (255 frame slips per 24 hours).

18.6 Loop Filter

The Loop Filter circuit gives frequency offset to the DCO circuit, based on the phase difference between the input and the feedback reference. It is similar to a first order low pass filter, with two positions for cut-off frequency (-3 dB attenuation) depending on the selected reference frequency, and it mainly determines the jitter transfer function of the DPLL.

In Primary Master mode when the selected input reference frequency is either 2.048 MHz, 1.544 MHz or 8 kHz, the cut-off frequency is approximately at 1.52 Hz and all the reference variations, including jitter, are attenuated according to the DPLL jitter transfer function (see Figure 17, "DPLL Jitter Transfer Function Diagram - wide range of frequencies" on page 42 and Figure 18, "Detailed DPLL Jitter Transfer Function Diagram" on page 43). The Loop Filter circuit ensures that the jitter transfer requirements in ETS 300-011 and Telescordia GR-499-CORE are met when the selected reference frequency is either 2.048 MHz, 1.544 MHz or 8 kHz.

When the selected input reference frequency is 8.192 MHz (i.e., in Secondary Master or Slave modes), the reference variations are bypassed to the output clocks. The cut-off frequency is at about 100 kHz, well beyond 500 Hz, the corner frequency of the Telcordia GR-1244-CORE input jitter tolerance curve.

The storage techniques, which enable generating very accurate output frequencies during the Holdover Mode of DPLL, are built into the Loop Filter circuit. When no jitter is presented on the selected input reference, the holdover frequency stability is 0.007 ppm.

18.7 Digitally Controlled Oscillator (DCO)

The DCO circuit adds frequency offset from the Loop Filter, which represents the phase error between the input and the feedback reference, to the ideal center frequency value and generates appropriately corrected output high speed clock. The Synchronization method of the DCO is dependent on the state of the DPLL State Machine module.

In the Normal Mode, the DCO circuit provides an output signal which is frequency and phase locked to the selected input reference signal.

In the Holdover Mode, the DCO circuit is running at a frequency that is equal to the frequency which was generated by the DCO circuit when the DPLL was in the Normal Mode.

In the Freerun Mode, the DCO circuit is free running at its center frequency with an output accuracy equal to the accuracy of the device master clock (C20i).

18.8 Divider

The Divider Circuit divides the DCO output frequency down to the required outputs. The following outputs are generated:

- C64 (65.536 MHz clock) - used as the internal clock for the MT90866 device.
- CT_C8 (8.192 MHz clock), C2M (2.048 MHz clock), C1M5o (1.544 MHz clock) and CT_FRAME (8 kHz negative frame pulse) - feedback reference signals to the Frequency Select MUX Circuit.
The CT_FRAME and the CT_C8 are required clocks. C1M5o is provided as an output clock of the MT90866.

The duty cycle of all output signals is independent of the duty cycle of the device master clock, C20i. The CT_C8, C2M and C1M5o clocks have nominal 50% duty cycle.

The output frame pulse (CT_FRAME) is generated in such a way that it is always aligned with the CT_C8 clock to form the required H.110 CT Bus clock and frame pulse shape (when the CT_FRAME is low the rising edge of the CT_C8 defines the frame boundary). Depending on the selected input reference frequency, the CT_FRAME is generated in the following way:

- When the input reference frequency is 8 kHz, the output frame pulse is aligned with the rising edge of the reference.
- When the reference frequency is either 2.048 MHz or 1.544 MHz, the CT_FRAME randomly defines the output frame boundary, always keeping the described relation to the CT_C8 clock.
- When the reference frequency is 8.192 MHz, the output frame pulse (CT_FRAME) has to be aligned with the input frame pulse (FRAME_A_io or FRAME_B_io). Since an 8.192 MHz clock (either C8_A_io or C8_B_io) is used as the reference clock, the selected frame pulse from the Frame Select MUX is provided as the input to the Divider circuit and the CT_FRAME is synchronized to it.

### 18.9 Frequency Select MUX Circuit

According to the selected input reference of the DPLL, this MUX will select the appropriate output frequency to be the feedback signal to the PLL and MTIE Circuits.

### 18.10 Modes of Operation

The DPLL can operate in two main modes: the Normal and the Holdover Mode. Each of these modes has two states: the primary or the secondary state. The state depends on which reference is currently selected as the preferred reference the PRI_REF or the SEC_REF. When the DPLL is in the Holdover Mode and the HRST bit of the DOM2 register is pulsed logic high (or held high continuously), the DPLL operates in Freerun Mode.

#### 18.10.1 Normal Mode

Normal Mode is typically used when a clock source synchronized to the network is required.

In the Normal Mode, the DPLL provides timing (C64, CT_C8, C2M and C1M5o) and frame synchronization (CT_FRAME) signals which are synchronized to one of two input references (PRI_REF or SEC_REF). The input reference signal may have a nominal frequency of 8 kHz, 1.544 MHz, 2.048 MHz or 8.192 MHz.

From a device reset condition or after reference switch, the DPLL can take up to 50 seconds to phase lock the output signals to the selected input reference signal.

#### 18.10.2 Holdover Mode

Holdover Mode is typically used for short durations while network synchronization is temporarily disrupted.

If the FDM1-0 bits are programmed to ’01’ in the DOM2 register and the PRI_LOS and SEC_LOS pins are high, the DPLL is in the Holdover Mode. The DPLL can also be in the Holdover Mode if the FDM1-0 bits are programmed to ’00’ and the SLS and PLS bit are observed as ‘11’ in the DPLL House Keeping Register (DHKR).

In the Holdover Mode, the DPLL provides timing and synchronization signals which are based on storage techniques and are not locked to an external reference signal. The storage value is determined while the device is in Normal Mode and locked to an external reference signal. When the DPLL is in the Normal Mode and locks to the input reference signal, a numerical value corresponding to the DPLL output reference frequency is stored alternately in two memory locations every 32 ms. When the device is switched into the Holdover Mode, the value in memory from between 32 ms and 64 ms is used to set the output frequency of the device.
The frequency stability of the Holdover Mode is ±0.07 ppm, which translates to a worst case 49 frame (125 µs) slips in 24 hours.

Two factors affect the frequency stability of the Holdover Mode. The first factor is the drift on the frequency of the master clock (C20i) while in the Holdover Mode. Drift on the master clock directly affects the Holdover Mode stability. Note that the absolute master clock stability does not affect the Holdover Frequency stability, only the change in C20i stability while in Holdover. For example, a ±32 ppm master clock may have a temperature coefficient of ±0.1 ppm/ °C. So a 10 degree change in temperature, while the DPLL is in the Holdover Mode may result in an additional offset (over the ±0.07 ppm) in frequency stability of ±1 ppm, which is much greater than the ±0.07 ppm of the DPLL. The second factor affecting Holdover frequency stability is large jitter on the reference input prior to the mode switch.

18.10.3 Freerun Mode

When the DPLL is in the Holdover Mode and the HRST bit of the DOM2 register is pulsed logic high (or held high continuously), the device is in Freerun Mode.

In Freerun Mode, the DPLL provides timing and synchronization signals which are based on the frequency of the master clock (C20i) only, and are not synchronized to the reference input signals. The frequency of the output signals is an ideal frequency with the freerun accuracy of -0.03 ppm plus the accuracy of the master clock (i.e., CT_C8 has frequency of 8.192 MHz +/- C20i_accuracy - 0.03 ppm).

Freerun Mode is typically used when a master clock source is required, or immediately following system power-up before network synchronization is achieved.

19.0 Measures of Performance

The following are some the DPLL performance indicators and their corresponding definitions.

19.1 Intrinsic Output Jitter

Intrinsic jitter is the jitter produced by the synchronizing circuit and is measured at its output. It is measured by applying a reference signal with no jitter to the input of the device, and measuring its output jitter. Intrinsic jitter may also be measured when the device is in a non-synchronizing mode, such as freerun or holdover, by measuring the output jitter of the device. Intrinsic jitter is usually measured with various band-limiting filters depending on the applicable standards.

19.2 Jitter Tolerance

Jitter tolerance is a measure of the ability of a PLL to operate properly without cycle slips (i.e., remain in lock and regain lock in the presence of large jitter magnitudes at various jitter frequencies) when jitter is applied to its reference. The applied jitter magnitude and the jitter frequency depends on the applicable standards. The input jitter tolerance of the DPLL depends on the selected reference frequency and can not exceed: ± 15 U.I. for E1 or T1 references, and ± 1 U.I. for 8 kHz references.

19.3 Jitter Transfer

Jitter transfer or jitter attenuation refers to the magnitude of jitter at the output of a device for a given amount of jitter at the input of the device. Input jitter is applied at various amplitudes and frequencies, and output jitter is measured with various filters depending on the applicable standards.

In slave and secondary master mode the H.110 standard requires the “B Clocks” to be edge-synchronous with the “A Clocks”, as long as jitter on the “A Clocks” meets Telcordia GR-1244-CORE specifications. Therefore in these two modes no jitter attenuation is performed.
In primary master mode the jitter attenuation of the DPLL is determined by the internal 1.52 Hz low pass Loop Filter and the Phase Slope Limiter. Figure 17, "DPLL Jitter Transfer Function Diagram - wide range of frequencies" on page 42 shows the DPLL jitter transfer function diagram in a wide range of frequencies, while Figure 18, "Detailed DPLL Jitter Transfer Function Diagram" on page 43 is the portion of the diagram from Figure 17 around 0 dB of the jitter transfer amplitude. At this point it is possible to see that when operating in primary master mode the DPLL is a second order, type 2 PLL. The jitter transfer function can be described as a low pass filter to 1.52 Hz, -20 dB/decade, with peaking less than 0.5 dB.

All outputs are derived from the same signal, therefore these diagrams apply to all outputs. Since 1 U.I. at 1.544 MHz (648 nsPP) is not equal to 1 U.I. at 2.048 MHz (488 nsPP), a transfer value using different input and output frequencies must be calculated in common units (e.g., seconds) as shown in the following example:

**What is the T1 and E1 output jitter when the T1 input jitter is 20 U.I. (T1 U.I. Units) and the T1 to T1 jitter attenuation is 18 dB, for a given jittering frequency?**

\[
\text{OutputT1} = \frac{\text{InputT1} \times 10^{-4}}{20}
\]

\[
\text{OutputT1} = 20 \times 10^{-10} = 2.5 \text{UI(T1)}
\]

\[
\text{OutputE1} = \text{OutputT1} \times \frac{(1 \text{UI1})}{(1 \text{UIE1})}
\]

\[
\text{OutputE1} = \text{OutputT1} \times \frac{644 \text{ns}}{488 \text{ns}} = 3.3 \text{UI(T1)}
\]

Using the method mentioned above, the jitter attenuation can be calculated for all combinations of inputs and outputs.

Because intrinsic jitter is always present, the jitter attenuation will appear to be lower for small input jitter signals than for large ones. Consequently, accurate jitter transfer function measurements are usually made with large input jitter signals (e.g., 75% of the specified maximum jitter tolerance).
19.4 Frequency Accuracy

Frequency accuracy is defined as the absolute tolerance of an output clock signal when the DPLL is not locked to an external reference, but is operating in the Freerun Mode. Because the output of the DCO Circuit has only discrete values, the output frequency of the DPLL has the limited accuracy of 0.03 ppm based upon the design implementation. In addition, the master clock (C20i) accuracy also directly affects the freerun accuracy. The freerun accuracy is then, 0.03 ppm plus the master clock accuracy.

19.5 Holdover Frequency Stability

Holdover frequency stability is defined as the maximum fractional frequency offset of an output clock signal when it is operating using a stored frequency value. For the DPLL, the stored value is determined while the device is in Normal Mode and locked to an external reference signal. As a result, when the DPLL is in the Normal Mode, the stability of the master clock (C20i) does not affect the holdover frequency stability because the DPLL will compensate for master clock changes while in Normal Mode. However, when the DPLL is in the Holdover Mode, the stability of the master clock does affect the Holdover frequency stability. The holdover frequency stability is 0.07 ppm assuming that the C20i frequency is held constant.

19.6 Locking Range

The locking range is the input frequency range over which the DPLL must be able to pull into synchronization and to maintain the synchronization. The locking range is defined by the Loop Filter Circuit and is equal to +/- 298 ppm.

Note that the locking range is related to the master clock (C20i). If the master clock is shifted by -100 ppm, the whole locking range also shifts -100 ppm downwards to be: -398 ppm to 198 ppm.
19.7 Phase Slope

The phase slope or the phase alignment speed is the rate at which a given signal changes phase with respect to an ideal signal. The given signal is typically the output signal. The ideal signal is of constant frequency and is nominally equal to the value of the final output signal or final input signal. Many telecom standards like Telcordia GR-1244-CORE state that the phase slope may not exceed a certain value, usually 81 ns/1.327 ms (61 ppm). This can be achieved by limiting the phase detector output to 61 ppm or less.

In the DPLL when operating in primary master mode the Phase Slope Limiter Circuit achieves the maximum phase slope to be: 56 ppm or 7.0 ns/125 us. When operating in secondary master or slave mode the output edges follow the input edges in accordance with the H.110 standard.

19.8 Maximum Time Interval Error (MTIE)

MTIE is the maximum peak to peak delay between a given timing signal and an ideal timing signal within a particular observation period.

For the DPLL, the maximum time interval error is less than 21 ns per reference switch.

19.9 Phase Lock Time

The Phase Lock Time is the time it takes the PLL to phase lock to the input signal. Phase lock occurs when the input and the output signals are not changing in phase with respect to each other (not including jitter).

Lock time is very difficult to determine because it is affected by many factors which include:

i) initial input to output phase difference
ii) initial input to output frequency difference
iii) PLL loop filter
iv) PLL limiter

Although a short phase lock time is desirable, it is not always possible to achieve due to other PLL requirements. For instance, better jitter transfer performance is achieved with a lower frequency loop filter which increases lock time, but better (smaller) phase slope performance (limiter) results in longer lock times. The DPLL loop filter and limiter were optimized to meet the Telcordia GR-499-CORE jitter transfer and Telcordia GR-1244-CORE phase alignment speed requirements. Consequently, phase lock time, which is not a standards requirement, is less than 50 seconds.

20.0 Initialization of the MT90866

During power up, the \text{TRST} pin should be pulled low to ensure that the MT90866 is in the functional mode. An external pull-down resistor is required on this pin so that the MT90866 will not enter the JTAG test mode during power up.

After power up, the contents of the connection memory can be in any state. The ODE pin should be held low after power up to keep all serial outputs in a high impedance state until the microprocessor has initialized the switching matrix. This procedure prevents two serial outputs from driving the same stream simultaneously. To ensure proper operation, a delay of 600 $\mu$s must be applied before the first microprocessor access is performed after the \text{RESET} pin is set high.

During the microprocessor initialization routine, the microprocessor should program the desired active paths through the switch. The memory block programming feature can also be used to quickly initialize the backplane and local connection memories.

When this process is completed, the microprocessor controlling the MT90866 can bring the ODE pin high to relinquish the high impedance state control.
21.0 JTAG Support

The MT90866 JTAG interface conforms to the Boundary-Scan IEEE1149.1 standard. The operation of the boundary-scan circuitry is controlled by an external Test Access Port (TAP) Controller.

21.1 Test Access Port (TAP)

The Test Access Port (TAP) accesses the MT90866 test functions. It consists of three input pins and one output pin as follows:

- **Test Clock Input (TCK)** - TCK provides the clock for the test logic. The TCK does not interfere with any on-chip clock and thus remains independent in the functional mode. The TCK permits shifting of test data into or out of the Boundary-Scan register cells concurrently with the operation of the device and without interfering with the on-chip logic.

- **Test Mode Select Input (TMS)** - The TAP Controller uses the logic signals received at the TMS input to control test operations. The TMS signals are sampled at the rising edge of the TCK pulse. This pin is internally pulled to Vdd when it is not driven from an external source.

- **Test Data Input (TDI)** - Serial input data applied to this port is fed either into the instruction register or into a test data register, depending on the sequence previously applied to the TMS input. Both registers are described in a subsequent section. The received input data is sampled at the rising edge of TCK pulses. This pin is internally pulled to Vdd when it is not driven from an external source.

- **Test Data Output (TDO)** - Depending on the sequence previously applied to the TMS input, the contents of either the instruction register or data register are serially shifted out towards the TDO. The data out of the TDO is clocked on the falling edge of the TCK pulses. When no data is shifted through the boundary scan cells, the TDO driver is set to a high impedance state.

- **Test Reset (TRST)** - Resets the JTAG scan structure. This pin is internally pulled to Vdd when it is not driven from an external source.

21.2 Instruction Register

The MT90866 uses the public instructions defined in the IEEE 1149.1 standard. The JTAG Interface contains a four-bit instruction register. Instructions are serially loaded into the instruction register from the TDI when the TAP Controller is in its shifted-IR state. These instructions are subsequently decoded to achieve two basic functions: to select the test data register that may operate while the instruction is current and to define the serial test data register path that is used to shift data between TDI and TDO during data register scanning.

21.3 Test Data Register

As specified in IEEE 1149.1, the MT90866 JTAG Interface contains three test data registers:

- **The Boundary-Scan Register** - The Boundary-Scan register consists of a series of Boundary-Scan cells arranged to form a scan path around the boundary of the MT90866 core logic.

- **The Bypass Register** - The Bypass register is a single stage shift register that provides a one-bit path from TDI to its TDO.

- **The Device Identification Register** - The JTAG device ID for the MT90866 is 0086614B_H.

  Version<31:28>: 0000
  Part No. <27:12>: 0000 1000 0110 0110
  Manufacturer ID<11:1>: 0001 0100 101
  LSB<0>: 1

21.4 BSDL

A BSDL (Boundary Scan Description Language) file is available from Zarlink Semiconductor to aid in the use of the IEEE 1149 test interface.
22.0  Register Descriptions

<table>
<thead>
<tr>
<th>Bit</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>15-14</td>
<td>Unused</td>
<td>Reserved.</td>
</tr>
<tr>
<td></td>
<td></td>
<td>ST-BUS Frame Pulse and Clock Output Selection 1: These two bits are used to select different ST-BUS output frame pulse (ST_FPo1) and clock (ST_CKo1).</td>
</tr>
<tr>
<td>11-10</td>
<td>STS1-0</td>
<td>ST-BUS Frame Pulse and Clock Output Selection 0: These two bits are used to select different ST-BUS output frame pulse (ST_FPo0) and clock (ST_CKo0).</td>
</tr>
<tr>
<td>9</td>
<td>PRST</td>
<td>PRBS Reset: When high, the PRBS transmitter output will be initialized.</td>
</tr>
<tr>
<td>8</td>
<td>CBERB</td>
<td>Backplane Bit Error Rate Clear: A low to high transition of this bit will reset the backplane internal bit error counter and the backplane BER register (BBERR).</td>
</tr>
<tr>
<td>7</td>
<td>SBERB</td>
<td>Backplane Start Bit Error Rate Test: A low to high transition in this bit starts the backplane bit error rate test. The bit error test result is kept in the backplane BER register (BBERR).</td>
</tr>
<tr>
<td>6</td>
<td>CBERL</td>
<td>Local Bit Error Rate Clear: A low to high transition of this bit will reset the local internal bit error counter and the BER register (LBERR).</td>
</tr>
<tr>
<td>5</td>
<td>SBERL</td>
<td>Local Start Bit Error Rate Test: A low to high transition in this bit starts the local bit error rate test. The bit error test result is kept in the local BER register (LBERR).</td>
</tr>
<tr>
<td>4</td>
<td>Unused</td>
<td>Reserved. In functional mode, this bit MUST be low.</td>
</tr>
<tr>
<td>3</td>
<td>MBP</td>
<td>Memory Block Programming: When this bit is high, the connection memory block programming feature is ready for the programming of bit 13 to bit 15 of the backplane connection memory and local connection memory low. When it is low this feature is disabled.</td>
</tr>
</tbody>
</table>

Table 9 - Control Register (CR) Bits
### Table 9 - Control Register (CR) Bits (continued)

**Read/Write Address:** 0001<sub>H</sub>

**Reset Value:** 0000<sub>H</sub>

<table>
<thead>
<tr>
<th>Bit</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>15</td>
<td>Unused</td>
<td>Reserved.</td>
</tr>
<tr>
<td>14</td>
<td>BMS</td>
<td>Backplane Mode Select: This bit refers to the different mode for the backplane interface.</td>
</tr>
<tr>
<td>13-12</td>
<td>LG41-LG40</td>
<td>Local Group 4 Mode Select: These two bits refer to different switching mode for group 4 (STi16-27 and STo16-27) of the local interface. When operating at 4Mb/s or 8Mb/s, the STo19-27 are driven low.</td>
</tr>
<tr>
<td>11-9</td>
<td>LG32-LG30</td>
<td>Local Group 3 Mode Select: These three bits refer to different switching mode for group 3 (STi12-15 and STo12-15) of the local interface.</td>
</tr>
</tbody>
</table>

### Table 10 - Device Mode Selection (DMS) Register Bits

**Memory Select Bits:** These three bits are used to select different connection and data memories.

<table>
<thead>
<tr>
<th>MS2</th>
<th>MS11</th>
<th>MS0</th>
<th>Memory Selection</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>0</td>
<td>0</td>
<td>Local Connection Memory Low</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>Read/Write</td>
</tr>
<tr>
<td>0</td>
<td>0</td>
<td>1</td>
<td>Local Connection Memory High</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>Read/Write</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>0</td>
<td>Backplane Connection Memory</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>Read/Write</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>1</td>
<td>Local Data Memory Read</td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>0</td>
<td>Backplane Data Memory Read</td>
</tr>
</tbody>
</table>

**Table 10 - Device Mode Selection (DMS) Register Bits**
### Local Group 2 Mode Select

These three bits refer to different switching modes for group 2 (STi8-11 and STo8-11) of the local interface.

<table>
<thead>
<tr>
<th>LG22</th>
<th>LG21</th>
<th>LG20</th>
<th>Switching Mode</th>
<th>Usable Streams</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>0</td>
<td>0</td>
<td>8 Mb/s</td>
<td>STi8-11, STo8-11</td>
</tr>
<tr>
<td>0</td>
<td>0</td>
<td>1</td>
<td>4 Mb/s</td>
<td>STi8-11, STo8-11</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>0</td>
<td>2 Mb/s</td>
<td>STi8-11, STo8-11</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>1</td>
<td>4-bit wide subrate</td>
<td>STi8-11, STo8-11</td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>0</td>
<td>2-bit wide subrate</td>
<td>STi8-11, STo8-11</td>
</tr>
</tbody>
</table>

### Local Group 1 Mode Select

These three bits refer to different switching modes for group 1 (STi4-7 and STo4-7) of the local interface.

<table>
<thead>
<tr>
<th>LG12</th>
<th>LG11</th>
<th>LG10</th>
<th>Switching Mode</th>
<th>Usable Streams</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>0</td>
<td>0</td>
<td>8 Mb/s</td>
<td>STi4-7, STo4-7</td>
</tr>
<tr>
<td>0</td>
<td>0</td>
<td>1</td>
<td>4 Mb/s</td>
<td>STi4-7, STo4-7</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>0</td>
<td>2 Mb/s</td>
<td>STi4-7, STo4-7</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>1</td>
<td>4-bit wide subrate</td>
<td>STi4-7, STo4-7</td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>0</td>
<td>2-bit wide subrate</td>
<td>STi4-7, STo4-7</td>
</tr>
</tbody>
</table>

### Local Group 0 Mode Select

These three bits refer to different switching modes for group 0 (STi0-3 and STo0-3) of the local interface.

<table>
<thead>
<tr>
<th>LG02</th>
<th>LG01</th>
<th>LG00</th>
<th>Switching Mode</th>
<th>Usable Streams</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>0</td>
<td>0</td>
<td>8 Mb/s</td>
<td>STi0-3, STo0-3</td>
</tr>
<tr>
<td>0</td>
<td>0</td>
<td>1</td>
<td>4 Mb/s</td>
<td>STi0-3, STo0-3</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>0</td>
<td>2 Mb/s</td>
<td>STi0-3, STo0-3</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>1</td>
<td>4-bit wide subrate</td>
<td>STi0-3, STo0-3</td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>0</td>
<td>2-bit wide subrate</td>
<td>STi0-3, STo0-3</td>
</tr>
</tbody>
</table>

Table 10 - Device Mode Selection (DMS) Register Bits (continued)
### Table 11 - Block Programming Mode (BPM) Register Bits

<table>
<thead>
<tr>
<th>Bit</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>15-9</td>
<td>Unused</td>
<td>Reserved. In functional mode, these bits MUST be low.</td>
</tr>
<tr>
<td>8-6</td>
<td>BBPD2-0</td>
<td><strong>Backplane Block Programming Data Bits:</strong> These bits carry the value to be loaded into the backplane connection memory block whenever the Memory Block Programming feature is activated. After the MBP bit in the control register is set to high and the BPE is set to high, the contents of the bits BBPD2 - 0 are loaded into bits 15 - 13 of the backplane connection memory. Bits 12 - 0 of the backplane connection memory are programmed to be zero.</td>
</tr>
<tr>
<td>5-3</td>
<td>LBPD2-0</td>
<td><strong>Local Block Programming Data Bits:</strong> These bits carry the value to be loaded into the local connection memory low whenever the Memory Block Programming feature is activated. After the MBP bit in the control register is set to high and the BPE is set to high, the contents of the bits LBPD2 - 0 are loaded into bits 15 - 13 of the local connection memory low. Bits 12 - 0 of the local connection memory low and bits 15 - 0 of the local connection memory high are programmed to be zero.</td>
</tr>
<tr>
<td>2</td>
<td>BPE</td>
<td><strong>Block Programming Enable:</strong> A low to high transition of this bit enables the Memory Block Programming function. The BPE, BBPD2-0 and LBPD2-0 in the BPM register have to be defined in the same write operation. Once the BPE bit is set to high, MT90866 requires two frames to complete the block programming. After the block programming has finished, the BPE bit returns to low to indicate that the operation is complete. When BPE is high, BPE or MBP can be set to low to abort the programming operation. When BPE is high, the other bits in the BPM register must not be changed for two frames to ensure proper operation. Whenever the microprocessor writes BPE to be high to start the block programming function, the user must maintain the same logical value on the other bits in the BPM register to avoid any change in the setting of the device.</td>
</tr>
<tr>
<td>1-0</td>
<td>Unused</td>
<td>Reserved. In functional mode, these bits MUST be low.</td>
</tr>
</tbody>
</table>
Local Input Delay Bits 4 - 0: These five bits define how long the serial interface receiver takes to recognize and to store bit 0 from the STI input pins: i.e., to start a new frame. The input delay can be selected to +7.75 data rate clock periods from the frame boundary.

Note 1: n denotes an STI stream number from 0 to 27.

Table 12 - Local Input Bit Delay Registers (LIDR0 to LIDR9) Bits
## Table 13 - Local Input Bit Delay Programming

<table>
<thead>
<tr>
<th>Local Input Bit Delay</th>
<th>Corresponding Delay Bits</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>LIDn4</td>
</tr>
<tr>
<td>No clock period shift (Default)</td>
<td>0</td>
</tr>
<tr>
<td>+ 1/4 data rate clock period</td>
<td>0</td>
</tr>
<tr>
<td>+ 1/2 data rate clock period</td>
<td>0</td>
</tr>
<tr>
<td>+ 3/4 data rate clock period</td>
<td>0</td>
</tr>
<tr>
<td>+ 1 data rate clock period</td>
<td>0</td>
</tr>
<tr>
<td>+ 1 1/4 data rate clock period</td>
<td>0</td>
</tr>
<tr>
<td>+ 1 1/2 data rate clock period</td>
<td>0</td>
</tr>
<tr>
<td>+ 1 3/4 data rate clock period</td>
<td>0</td>
</tr>
<tr>
<td>+ 2 data rate clock period</td>
<td>0</td>
</tr>
<tr>
<td>............</td>
<td>.......</td>
</tr>
<tr>
<td>+ 7 3/4 data rate clock period</td>
<td>1</td>
</tr>
</tbody>
</table>

## Figure 19 - Local Input Bit Delay Timing

- Bit Delay 0
  - LID=00000
- Bit Delay 1/4
  - LID=00001
- Bit Delay 1/2
  - LID=00010
- Bit Delay 3/4
  - LID=00011
- Bit Delay 1
  - LID=00100
- Bit Delay 1 1/2
  - LID=00101
Figure 20 - Example of Backplane Output Advancement Timing

Name) Description

BOAn1, BOAn0 (See Note 1) Backplane Output Advancement Bits 1 - 0: These two bits represent the amount of offset that a particular stream output can be advanced. When the offset is zero, the serial output stream has normal alignment with the frame pulse.

<table>
<thead>
<tr>
<th>BOAn1</th>
<th>BOAn0</th>
<th>Output Advancement</th>
<th>C8_A_io or C8_B_io period</th>
<th>8.192 Mb/s (bit)</th>
<th>16.384 Mb/s (bit)</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>0</td>
<td>0 ns</td>
<td>0</td>
<td>0</td>
<td>0</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>7.5 ns</td>
<td>-1/16</td>
<td>-1/16</td>
<td>-1/8</td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>15 ns</td>
<td>-1/8</td>
<td>-1/8</td>
<td>-1/4</td>
</tr>
<tr>
<td>1</td>
<td>1</td>
<td>22.5 ns</td>
<td>-3/16</td>
<td>-3/16</td>
<td>-3/8</td>
</tr>
</tbody>
</table>

Note 1: n denotes a STio stream number from 0 to 31.

Table 14 - Backplane Output Advancement Registers (BOAR0 to BOAR3) Bit

[frame diagram of bit cell advancement and timing]

Figure 20 - Example of Backplane Output Advancement Timing
Figure 21 - Local Output Advancement Timing

Name Description

LOAn1, LOAn0 (See Note 1)

Local Output Advancement Bits 1-0: These two bits represent the amount of offset that a particular stream output can be advanced. When the offset is zero, the serial output stream has normal alignment with the frame pulse.

<table>
<thead>
<tr>
<th>LOAn1</th>
<th>LOAn0</th>
<th>Output Advancement</th>
<th>C6_A_io or C6_B_io period</th>
<th>2.048 Mb/s (bit)</th>
<th>4.096 Mb/s (bit)</th>
<th>8.192 Mb/s (bit)</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>0</td>
<td>0 ns</td>
<td></td>
<td>0</td>
<td>0</td>
<td>0</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>- 7.5 ns</td>
<td>- 1/64</td>
<td>- 1/32</td>
<td>- 1/16</td>
<td></td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>- 15 ns</td>
<td>- 1/32</td>
<td>- 1/16</td>
<td>- 1/8</td>
<td></td>
</tr>
<tr>
<td>1</td>
<td>1</td>
<td>- 22.5 ns</td>
<td>- 3/16</td>
<td>- 3/32</td>
<td>- 3/16</td>
<td></td>
</tr>
</tbody>
</table>

Note 1: n denotes a STi stream number from 0 to 27.

Table 15 - Local Output Advancement Registers (LOAR0 to LOAR3) Bits

- **C64** (internal clock)
- **ST_FPo0/1**
- **8 Mb/s Stream**
- **8 Mb/s Stream**
- **8 Mb/s Stream**
- **8 Mb/s Stream**
- **8 Mb/s Stream**
- **8 Mb/s Stream**
- **8 Mb/s Stream**
- **8 Mb/s Stream**
- advancement is 0 ns LOA=00
- advancement is 7.5 ns LOA=01
- advancement is 15 ns LOA=10
- advancement is 22.5 ns LOA=11
- denotes the starting point of the bit cell

Figure 21 - Local Output Advancement Timing
### Table 16 - Local Bit Error Rate Input Selection (LBIS) Register Bits

<table>
<thead>
<tr>
<th>Bit</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>15 - 13</td>
<td>Unused</td>
<td>Reserved.</td>
</tr>
<tr>
<td>12 - 8</td>
<td>LBSA4 - LBSA0</td>
<td><strong>Local BER Input Stream Address Bits:</strong> These bits refer to the local input data stream which receives the BER data.</td>
</tr>
<tr>
<td>7 - 0</td>
<td>LBCA7 - LBCA0</td>
<td><strong>Local BER Input Channel Address Bits:</strong> These bits refer to the local input channel which receives the BER data.</td>
</tr>
</tbody>
</table>

### Table 17 - Local Bit Error Rate Register (LBERR) Bits

<table>
<thead>
<tr>
<th>Bit</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>15 - 0</td>
<td>LBER15 - LBER0</td>
<td><strong>Local Bit Error Rate Count Bits:</strong> These bits refer to the local bit error counts. This counter stops incrementing when it reaches the value 0xFFFF.</td>
</tr>
</tbody>
</table>

### Table 18 - Backplane Bit Error Rate Input Selection (BBIS) Register Bits

<table>
<thead>
<tr>
<th>Bit</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>15 - 13</td>
<td>Unused</td>
<td>Reserved.</td>
</tr>
<tr>
<td>12 - 8</td>
<td>BBSA4 - BBSA0</td>
<td><strong>Backplane BER Input Stream Address Bits:</strong> These bits refer to the backplane input data stream which receives the BER data.</td>
</tr>
<tr>
<td>7 - 0</td>
<td>BBCA7 - BBCA0</td>
<td><strong>Backplane BER Input Channel Address Bits:</strong> These bits refer to the backplane input channel which receives the BER data.</td>
</tr>
</tbody>
</table>
### Table 19 - Backplane Bit Error Rate Register (BBERR) Bits

<table>
<thead>
<tr>
<th>Bit</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>15 - 0</td>
<td>BBER15 - BBER0</td>
<td><strong>Backplane Bit Error Rate Count Bits:</strong> These bits refer to the backplane bit error count. This counter stops incrementing when it reaches the value 0xFFFF.</td>
</tr>
</tbody>
</table>

### Table 20 - DPLL Operation Mode (DOM1) Register Bits

<table>
<thead>
<tr>
<th>Bit</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>15</td>
<td>CNEN</td>
<td><strong>NREFo Output Enable Bit:</strong> When CNEN is low, NREFo output is disabled, i.e. tri-stated. When CNEN is high, NREFo output is enabled.</td>
</tr>
<tr>
<td>14</td>
<td>BEN</td>
<td><strong>B Clocks Output Enable Bit:</strong> When BEN is low, the “B Clocks” (C8_B_io and FRAME_B_io) are disabled, i.e. tri-stated - C8_B_io and FRAME_B_io behave as inputs. When BEN is high, the “B Clocks” are enabled - C8_B_io and FRAME_B_io behave as outputs.</td>
</tr>
<tr>
<td>13</td>
<td>AEN</td>
<td><strong>A Clocks Output Enable Bit:</strong> When AEN is low, the “A Clocks” (C8_A_io and FRAME_A_io) are disabled, i.e. tri-stated - C8_A_io and FRAME_A_io behave as inputs. When AEN is high, the “A Clocks” are enabled - C8_A_io and FRAME_A_io behave as outputs.</td>
</tr>
<tr>
<td>12</td>
<td>RPS</td>
<td><strong>Reference Selection Bit:</strong> When RPS is low, the preferred reference is the primary reference (PRI_REF). When RPS is high, the preferred reference is the secondary reference (SEC_REF).</td>
</tr>
<tr>
<td>11 - 10</td>
<td>FS1 - FS0</td>
<td><strong>SEC_REF Frequency Selection Bits:</strong> These bits are used to select different clock frequencies for the secondary reference.</td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>FS1</th>
<th>FS0</th>
<th>Secondary Reference</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>0</td>
<td>8 kHz</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>1.544 MHz</td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>2.048 MHz</td>
</tr>
<tr>
<td>1</td>
<td>1</td>
<td>8.192 MHz (&quot;A Clocks&quot; or &quot;B Clocks&quot;)</td>
</tr>
<tr>
<td>Bit</td>
<td>Name</td>
<td>Description</td>
</tr>
<tr>
<td>-----</td>
<td>------------</td>
<td>-----------------------------------------------------------------------------</td>
</tr>
<tr>
<td>9 - 8</td>
<td>FP1 - FP0</td>
<td><strong>PRI_REF Frequency Selection Bits</strong>: These bits are used to select different clock frequencies for the primary reference.</td>
</tr>
<tr>
<td></td>
<td></td>
<td><strong>Table 20 - DPLL Operation Mode (DOM1) Register Bits (continued)</strong></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td><strong>FS1</strong></td>
</tr>
<tr>
<td></td>
<td></td>
<td>0</td>
</tr>
<tr>
<td></td>
<td></td>
<td>0</td>
</tr>
<tr>
<td></td>
<td></td>
<td>1</td>
</tr>
<tr>
<td></td>
<td></td>
<td>1</td>
</tr>
<tr>
<td>7 - 4</td>
<td>SS3 - SS0</td>
<td><strong>Secondary Clock Reference Input Selection Bits</strong>: These bits are used to select secondary reference input.</td>
</tr>
<tr>
<td></td>
<td></td>
<td><strong>Table 20 - DPLL Operation Mode (DOM1) Register Bits (continued)</strong></td>
</tr>
<tr>
<td></td>
<td></td>
<td><strong>SS3 - SS0</strong></td>
</tr>
<tr>
<td></td>
<td></td>
<td>0000</td>
</tr>
<tr>
<td></td>
<td></td>
<td>0001</td>
</tr>
<tr>
<td></td>
<td></td>
<td>0010</td>
</tr>
<tr>
<td></td>
<td></td>
<td>0011</td>
</tr>
<tr>
<td></td>
<td></td>
<td>0100</td>
</tr>
<tr>
<td></td>
<td></td>
<td>0101</td>
</tr>
<tr>
<td></td>
<td></td>
<td>0110</td>
</tr>
<tr>
<td></td>
<td></td>
<td>0111</td>
</tr>
<tr>
<td></td>
<td></td>
<td>1000</td>
</tr>
<tr>
<td></td>
<td></td>
<td>1001</td>
</tr>
<tr>
<td></td>
<td></td>
<td>1010</td>
</tr>
<tr>
<td></td>
<td></td>
<td>1011</td>
</tr>
<tr>
<td></td>
<td></td>
<td>1100</td>
</tr>
<tr>
<td></td>
<td></td>
<td>1101</td>
</tr>
<tr>
<td></td>
<td></td>
<td>1110</td>
</tr>
<tr>
<td></td>
<td></td>
<td>1111</td>
</tr>
</tbody>
</table>
Primary Clock Reference Input Selection Bits: These bits are used to select primary reference input.

<table>
<thead>
<tr>
<th>Bit</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>3-0</td>
<td>SP3 - SP0</td>
<td>Primary Clock Reference Input</td>
</tr>
<tr>
<td></td>
<td></td>
<td>SP3 - SS0</td>
</tr>
<tr>
<td>0000</td>
<td></td>
<td>CTREF1</td>
</tr>
<tr>
<td>0001</td>
<td></td>
<td>CTREF2</td>
</tr>
<tr>
<td>0010</td>
<td></td>
<td>“A Clocks”</td>
</tr>
<tr>
<td>0011</td>
<td></td>
<td>“B Clocks”</td>
</tr>
<tr>
<td>0100</td>
<td></td>
<td>Reserved</td>
</tr>
<tr>
<td>0101</td>
<td></td>
<td>Reserved</td>
</tr>
<tr>
<td>0110</td>
<td></td>
<td>Reserved</td>
</tr>
<tr>
<td>0111</td>
<td></td>
<td>Reserved</td>
</tr>
<tr>
<td>1000</td>
<td></td>
<td>LREF0</td>
</tr>
<tr>
<td>1001</td>
<td></td>
<td>LREF1</td>
</tr>
<tr>
<td>1010</td>
<td></td>
<td>LREF2</td>
</tr>
<tr>
<td>1011</td>
<td></td>
<td>LREF3</td>
</tr>
<tr>
<td>1100</td>
<td></td>
<td>LREF4</td>
</tr>
<tr>
<td>1101</td>
<td></td>
<td>LREF5</td>
</tr>
<tr>
<td>1110</td>
<td></td>
<td>LREF6</td>
</tr>
<tr>
<td>1111</td>
<td></td>
<td>LREF7</td>
</tr>
</tbody>
</table>

Table 20 - DPLL Operation Mode (DOM1) Register Bits (continued)
### Table 21 - DPLL Operation Mode (DOM2) Register Bits

<table>
<thead>
<tr>
<th>Bit</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>15 - 12</td>
<td>Unused</td>
<td>Reserved.</td>
</tr>
<tr>
<td>11</td>
<td>HRST</td>
<td><strong>DPLL Hold Memory Reset Bit</strong>: When HRST is low, the DPLL hold memory circuit is in functional mode. When HRST is high, the hold memory circuit will be reset. While the DPLL is in Holdover Mode, pulsing HRST high (or holding it high continuously) will force the DPLL to the Freerun Mode.</td>
</tr>
<tr>
<td>10</td>
<td>MRST</td>
<td><strong>MTIE Reset Bit</strong>: When MRST is low, the DPLL MTIE circuit is in functional mode. When MRST is high, the MTIE circuit will be reset - the DPLL outputs will align with the nearest edge of the selected reference. When the MT90866 is operating in the slave mode, this bit <strong>MUST</strong> be set high to reset the MTIE circuit.</td>
</tr>
<tr>
<td>9 - 8</td>
<td>FDM1 - FDM0</td>
<td><strong>Failure Detect Mode Bits</strong>: These two bits control how to choose the Failure Detection.</td>
</tr>
<tr>
<td></td>
<td></td>
<td><strong>Failure Detection Mode</strong></td>
</tr>
<tr>
<td>FDM1</td>
<td>FDM0</td>
<td>Description</td>
</tr>
<tr>
<td>0</td>
<td>0</td>
<td>Autodetect - Automatic Failure Detection by internal reference monitor circuit</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>External - Failure Detection controlled by external inputs (PRI_LOS and SEC_LOS)</td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>Forced Primary - The DPLL is forced to use primary reference</td>
</tr>
<tr>
<td>1</td>
<td>1</td>
<td>Forced Secondary - The DPLL is forced to use secondary reference</td>
</tr>
<tr>
<td>7</td>
<td>BFEN</td>
<td><strong>FAIL_B Clocks Fail Output Enable Bit</strong>: When BFEN is low, FAIL_B output is disabled, i.e., tri-stated. When BFEN is high, FAIL_B output is enabled.</td>
</tr>
<tr>
<td>6</td>
<td>AFEN</td>
<td><strong>FAIL_A Clocks Fail Output Enable Bit</strong>: When AFEN is low, FAIL_A output is disabled, i.e., tri-stated. When AFEN is high, FAIL_A output is enabled.</td>
</tr>
<tr>
<td>5</td>
<td>CNIN</td>
<td><strong>CTREF1 and CTREF2 Inputs Inverted</strong>: When CNIN is high, the CTREF1 and CTREF2 inputs will be inverted, prior to entering the DPLL module. When CNIN is low, the CTREF1 and CTREF2 inputs will not be inverted.</td>
</tr>
</tbody>
</table>
### Divider Bits

These two bits define the relationship between the input reference and the NREFo output.

<table>
<thead>
<tr>
<th>DIV1</th>
<th>DIV0</th>
<th>NREFo Output</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>0</td>
<td>Input reference</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>Input reference/193 (8 KHz signal when input reference clock = 1.544 MHz)</td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>Input reference/256 (8 KHz signal when input reference clock = 2.048 MHz)</td>
</tr>
<tr>
<td>1</td>
<td>1</td>
<td>Reserved</td>
</tr>
</tbody>
</table>

### NREFo Source Selection Bits

These three bits select one of the LREF7 - LREF0 to be the NREFo source.

<table>
<thead>
<tr>
<th>CNS2</th>
<th>CNS1</th>
<th>CNS0</th>
<th>NREFo Source</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>0</td>
<td>0</td>
<td>LREF0</td>
</tr>
<tr>
<td>0</td>
<td>0</td>
<td>1</td>
<td>LREF1</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>0</td>
<td>LREF2</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>1</td>
<td>LREF3</td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>0</td>
<td>LREF4</td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>1</td>
<td>LREF5</td>
</tr>
<tr>
<td>1</td>
<td>1</td>
<td>0</td>
<td>LREF6</td>
</tr>
<tr>
<td>1</td>
<td>1</td>
<td>1</td>
<td>LREF7</td>
</tr>
</tbody>
</table>

Table 21 - DPLL Operation Mode (DOM2) Register Bits (continued)
## Table 22 - MT90866 Mode Selection - By Programming DOM1 and DOM2 Registers

<table>
<thead>
<tr>
<th>Bit</th>
<th>Primary Master Mode</th>
<th>Secondary Master Mode</th>
<th>Slave Mode</th>
</tr>
</thead>
<tbody>
<tr>
<td>BEN (bit 14)</td>
<td>0 - Monitor “B Clocks”</td>
<td>1 - Drive “B Clocks”</td>
<td>0 - Monitor “B Clocks”</td>
</tr>
<tr>
<td>AEN (bit 13)</td>
<td>1 - Drive “A Clocks”</td>
<td>0 - Monitor “A Clocks”</td>
<td>0 - Monitor “A Clocks”</td>
</tr>
<tr>
<td>RPS (bit 12)</td>
<td>0 - Preferred reference is PRI_REF</td>
<td>0 - Preferred reference is PRI_REF</td>
<td>0 - Preferred reference is PRI_REF</td>
</tr>
<tr>
<td>FS1-0 (bits 11-10)</td>
<td>Frequency of the secondary reference: 00 - 8 kHz</td>
<td>00 - 8 kHz</td>
<td>11 - 8.192 MHz Clock (“B Clocks”)</td>
</tr>
<tr>
<td></td>
<td>01 - 1.544 MHz</td>
<td>01 - 1.544 MHz</td>
<td></td>
</tr>
<tr>
<td></td>
<td>10 - 2.048 MHz</td>
<td>10 - 2.048 MHz</td>
<td></td>
</tr>
<tr>
<td>FP1-0 (bits 9-8)</td>
<td>Frequency of the primary reference: 00 - 8 kHz</td>
<td>11 - 8.192 MHz Clock (“A Clocks”)</td>
<td></td>
</tr>
<tr>
<td></td>
<td>01 - 1.544 MHz</td>
<td>11 - 8.192 MHz Clock (“A Clocks”)</td>
<td></td>
</tr>
<tr>
<td></td>
<td>10 - 2.048 MHz</td>
<td>11 - 8.192 MHz Clock (“A Clocks”)</td>
<td></td>
</tr>
<tr>
<td>SS3-0 (bits 7-4)</td>
<td>Secondary reference selection:</td>
<td>XXXX - C8_B_io</td>
<td>When bits FS1-0 are set to 11, C8_B_io is always used as the secondary reference, regardless of the values of bits SS3-0. Output frame pulses are aligned to FRAME_B_io if secondary reference is the active reference</td>
</tr>
<tr>
<td></td>
<td>0000 - CTREF1</td>
<td>0000 - CTREF1</td>
<td></td>
</tr>
<tr>
<td></td>
<td>0001 - CTREF2</td>
<td>0001 - CTREF2</td>
<td></td>
</tr>
<tr>
<td></td>
<td>1000 - LREF0</td>
<td>1000 - LREF0</td>
<td></td>
</tr>
<tr>
<td></td>
<td>1001 - LREF1</td>
<td>1001 - LREF1</td>
<td></td>
</tr>
<tr>
<td></td>
<td>1010 - LREF2</td>
<td>1010 - LREF2</td>
<td></td>
</tr>
<tr>
<td></td>
<td>1011 - LREF3</td>
<td>1011 - LREF3</td>
<td></td>
</tr>
<tr>
<td></td>
<td>1100 - LREF4</td>
<td>1100 - LREF4</td>
<td></td>
</tr>
<tr>
<td></td>
<td>1101 - LREF5</td>
<td>1101 - LREF5</td>
<td></td>
</tr>
<tr>
<td></td>
<td>1110 - LREF6</td>
<td>1110 - LREF6</td>
<td></td>
</tr>
<tr>
<td></td>
<td>1111 - LREF7</td>
<td>1111 - LREF7</td>
<td></td>
</tr>
<tr>
<td>SP3-0 (bits 3-0)</td>
<td>Primary reference selection: XXXX - C8_A_io</td>
<td>When bits SP3-0 are set to 11, C8_A_io is always used as the primary reference, regardless of the values of bits SP3-0. Output frame pulses are aligned to FRAME_A_io if primary reference is the active reference</td>
<td></td>
</tr>
<tr>
<td></td>
<td>0000 - CTREF1</td>
<td>XXXX - C8_A_io</td>
<td></td>
</tr>
<tr>
<td></td>
<td>0001 - CTREF2</td>
<td>XXXX - C8_A_io</td>
<td></td>
</tr>
<tr>
<td></td>
<td>1000 - LREF0</td>
<td>XXXX - C8_A_io</td>
<td></td>
</tr>
<tr>
<td></td>
<td>1001 - LREF1</td>
<td>XXXX - C8_A_io</td>
<td></td>
</tr>
<tr>
<td></td>
<td>1010 - LREF2</td>
<td>XXXX - C8_A_io</td>
<td></td>
</tr>
<tr>
<td></td>
<td>1011 - LREF3</td>
<td>XXXX - C8_A_io</td>
<td></td>
</tr>
<tr>
<td></td>
<td>1100 - LREF4</td>
<td>XXXX - C8_A_io</td>
<td></td>
</tr>
<tr>
<td></td>
<td>1101 - LREF5</td>
<td>XXXX - C8_A_io</td>
<td></td>
</tr>
<tr>
<td></td>
<td>1110 - LREF6</td>
<td>XXXX - C8_A_io</td>
<td></td>
</tr>
<tr>
<td></td>
<td>1111 - LREF7</td>
<td>XXXX - C8_A_io</td>
<td></td>
</tr>
<tr>
<td>MRST (bit 10)</td>
<td>0 - MTIE functional</td>
<td>0 - MTIE functional</td>
<td>1 - MTIE MUST be kept in the reset state in Slave mode</td>
</tr>
<tr>
<td></td>
<td>1 - MTIE reset</td>
<td>1 - MTIE reset</td>
<td></td>
</tr>
<tr>
<td>FDM1, FDM0 (bits 9-8)</td>
<td>Failure detect mode selection: 00 - Autodetect Mode</td>
<td>00 - Autodetect Mode</td>
<td>00 - Autodetect Mode</td>
</tr>
<tr>
<td></td>
<td>01 - External Mode</td>
<td>01 - External Mode</td>
<td>01 - External Mode</td>
</tr>
</tbody>
</table>

* Note 1: It is assumed that the switching among references is done by an external software control, if the External Mode is selected.
# DPLL Output Adjustment (DPOA) Register Bits

<table>
<thead>
<tr>
<th>Bit</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>15 - 9</td>
<td>POS6-POS0</td>
<td>Phase Offset Bits: These seven bits refer to the 2’s complement phase word to control the DPLL output phase offset. The offset varies in steps of 15 ns if the reference is 8 kHz or 2.048 MHz. The offset varies in steps of 20 ns if the reference is 1.544 MHz.</td>
</tr>
<tr>
<td>8 - 3</td>
<td>Unused</td>
<td>Reserved.</td>
</tr>
<tr>
<td>2 - 0</td>
<td>SKC2-SKC0</td>
<td>Skew Control Bits: These three bits control the delay of the DPLL outputs from 0 to 7 steps in interval of maximum unit delay of 3.5 ns.</td>
</tr>
</tbody>
</table>

## DPLL House Keeping (DHKR) Register Bits

<table>
<thead>
<tr>
<th>Bit</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>15 - 7</td>
<td>Unused</td>
<td>Reserved.</td>
</tr>
<tr>
<td>6</td>
<td>SLS</td>
<td>Secondary Loss Detection Bit (Read-only bit): This bit is the same as the output from the DPLL Reference Monitor FAIL_SEC.</td>
</tr>
<tr>
<td>5</td>
<td>PLS</td>
<td>Primary Loss Detection Bit (Read-only bit): This bit is the same as the output from the DPLL Reference Monitor FAIL_PRI.</td>
</tr>
<tr>
<td>4</td>
<td>CKM</td>
<td>DPLL Clock Monitor Bit: When high, the primary output C32/64o is 65.536 MHz clock. When low, the primary output C32/64o is 32.768 MHz clock. This is the only writable bit in this register.</td>
</tr>
<tr>
<td>3</td>
<td>Limit</td>
<td>Limit (Read-only bit): Indicates that DPLL Phase Slope limiter limits input phase.</td>
</tr>
</tbody>
</table>

---

**Read/Write Address:** 002D\text{H} for DPOA Register  
**Reset Value:** 0000\text{H}  

**Read/Write Address:** 002E\text{H} for DHKR Register  
**Reset Value:** 0000\text{H}
**State:** These 3 bits indicate the state of the DPLL State Machine. Please refer to Figure 14, “State Machine Diagram” on page 36.

<table>
<thead>
<tr>
<th>State 2-0</th>
<th>State Name</th>
</tr>
</thead>
<tbody>
<tr>
<td>000</td>
<td>NORMAL_PRI</td>
</tr>
<tr>
<td>001</td>
<td>Reserved</td>
</tr>
<tr>
<td>010</td>
<td>HOLDOVER_PRI</td>
</tr>
<tr>
<td>011</td>
<td>MTIE_PRI</td>
</tr>
<tr>
<td>100</td>
<td>NORMAL_SEC</td>
</tr>
<tr>
<td>101</td>
<td>Reserved</td>
</tr>
<tr>
<td>110</td>
<td>HOLDOVER_SEC</td>
</tr>
<tr>
<td>111</td>
<td>MTIE_SEC</td>
</tr>
</tbody>
</table>

Table 24 - DPLL House Keeping (DHKR) Register Bits (continued)
Throughput Delay and Message Control Bits: These three bits control the backplane CT-Bus input or output.

<table>
<thead>
<tr>
<th>BTM2-0</th>
<th>Throughput delay and Message Mode control</th>
</tr>
</thead>
<tbody>
<tr>
<td>000</td>
<td>Per-channel variable delay from local interface; the content of the connection memory is the local data memory address of the switched input channel and stream. The backplane CT-Bus output is from local ST-BUS input.</td>
</tr>
<tr>
<td>001</td>
<td>Per-channel constant delay from local interface; the content of the connection memory is the local data memory address of the switched input channel and stream. The backplane CT-Bus output is from local ST-BUS input.</td>
</tr>
<tr>
<td>010</td>
<td>Per-channel variable delay from backplane interface; the content of the connection memory is the backplane data memory address of the switched input channel and stream. The backplane CT-Bus output is from backplane CT-Bus input.</td>
</tr>
<tr>
<td>011</td>
<td>Per-channel constant delay from backplane interface; the content of the connection memory is the backplane data memory address of the switched input channel and stream. The backplane CT-Bus output is from backplane CT-Bus input.</td>
</tr>
<tr>
<td>100</td>
<td>Per-channel message mode; only the lower byte (bits 7 to 0) of the connection memory location will be the presented to the backplane CT-Bus output channel.</td>
</tr>
<tr>
<td>101</td>
<td>Per-channel BER pattern; the pseudo random BER test pattern will be presented to the backplane CT-Bus output channel.</td>
</tr>
<tr>
<td>110</td>
<td>Per-channel input. The backplane CT-Bus is input.</td>
</tr>
<tr>
<td>111</td>
<td>Reserved.</td>
</tr>
</tbody>
</table>

Source Stream Address Bits: These five bits refer to the number of the data streams for the source (local or backplane) connection.

Source Channel Address Bits: These eight bits refer to the number of the channel that is the source (local or backplane) connection.

Note 1: Only Bits 7-0 will be used for per-channel message mode for the backplane STio streams.

Table 25 - Backplane Connection Memory Bits
### Table 26 - BSAB and BCAB Bits Usage when Source Streams are from the Local Port

<table>
<thead>
<tr>
<th>Data Rate</th>
<th>Source Stream</th>
<th>BSAB Bit Usage</th>
<th>BCAB Bit Usage</th>
</tr>
</thead>
<tbody>
<tr>
<td>2 Mb/s</td>
<td>STi0-27</td>
<td>BSAB4-0</td>
<td>BCAB4-0 (32-ch/frame)</td>
</tr>
<tr>
<td>4 Mb/s</td>
<td>STi0-18</td>
<td>BSAB4-0</td>
<td>BCAB5-0 (64-ch/frame)</td>
</tr>
<tr>
<td>8 Mb/s</td>
<td>STi0-18</td>
<td>BSAB4-0</td>
<td>BCAB6-0 (128-ch/frame)</td>
</tr>
<tr>
<td>2-bit subrate</td>
<td>STi0-15</td>
<td>BSAB3-0</td>
<td>BCAB6-0 (128 ch/frame)</td>
</tr>
<tr>
<td>4-bit subrate</td>
<td>STi0-15</td>
<td>BSAB3-0</td>
<td>BCAB5-0 (64 ch/frame)</td>
</tr>
</tbody>
</table>

### Table 27 - BSAB and BCAB Bits Usage when Source Streams are from the Backplane Port

<table>
<thead>
<tr>
<th>Data Rate</th>
<th>Source Stream</th>
<th>BSAB Bit Usage</th>
<th>BCAB Bit Usage</th>
</tr>
</thead>
<tbody>
<tr>
<td>8 Mb/s</td>
<td>STio0-31</td>
<td>BSAB4-0</td>
<td>BCAB6-0 (128-ch/frame)</td>
</tr>
<tr>
<td>16 Mb/s</td>
<td>STio0-15</td>
<td>BSAB3-0</td>
<td>BCAB7-0 (256 ch/frame)</td>
</tr>
</tbody>
</table>

### Table 28 - Local Connection Memory High Bits

<table>
<thead>
<tr>
<th>Bit</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>15 - 2</td>
<td>Unused</td>
<td>Reserved.</td>
</tr>
<tr>
<td>1 - 0</td>
<td>LSRS1 - LSRS0</td>
<td><strong>Sub-rate Switching Bits:</strong></td>
</tr>
<tr>
<td></td>
<td></td>
<td>For the 4-bit wide sub-rate switching:</td>
</tr>
<tr>
<td></td>
<td></td>
<td><strong>LSRS1 - 0</strong> StOutput</td>
</tr>
<tr>
<td></td>
<td></td>
<td><strong>01</strong> Bit 7 - 4 of the 8 bit data</td>
</tr>
<tr>
<td></td>
<td></td>
<td><strong>00</strong> Bit 3 - 0 of the 8 bit data</td>
</tr>
<tr>
<td></td>
<td></td>
<td>For 2-bit wide sub-rate switching:</td>
</tr>
<tr>
<td></td>
<td></td>
<td><strong>LSRS1 - 0</strong> StOutput</td>
</tr>
<tr>
<td></td>
<td></td>
<td><strong>11</strong> Bit 7 - 6 of the 8 bit data</td>
</tr>
<tr>
<td></td>
<td></td>
<td><strong>10</strong> Bit 5 - 4 of the 8 bit data</td>
</tr>
<tr>
<td></td>
<td></td>
<td><strong>01</strong> Bit 3 - 2 of the 8 bit data</td>
</tr>
<tr>
<td></td>
<td></td>
<td><strong>00</strong> Bit 1 - 0 of the 8 bit data</td>
</tr>
</tbody>
</table>
## MT90866 Data Sheet

### Bit Name Description

<table>
<thead>
<tr>
<th>Bit</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>15 -13</td>
<td>LTM2 - 0</td>
<td><strong>Throughput Delay and Message Channel Control Bits:</strong> These three bits control the local ST-BUS output.</td>
</tr>
</tbody>
</table>

**LTM2-0**

- **Throughput delay and Message Mode control**
  - **000** Per-channel variable delay from local interface; the content of the connection memory is the local data memory address of the switched input channel and stream. The local ST-BUS output is from the local ST-BUS input.
  - **001** Per-channel constant delay from local interface; the content of the connection memory is the local data memory address of the switched input channel and stream. The local ST-BUS output is from the local ST-BUS input.
  - **010** Per-channel variable delay from backplane interface; the content of the connection memory is the backplane data memory address of the switched input channel and stream. The local ST-BUS output is from the backplane CT-Bus input.
  - **011** Per-channel constant delay from the backplane interface; the content of the connection memory is the backplane data memory address of the switched input channel and stream. The local ST-BUS output is from backplane CT-Bus input.
  - **100** Per-channel message mode; only the lower byte (bits 7 to 0) of the connection memory location will be presented to the local ST-BUS output channel.
  - **101** Per-channel BER pattern; the pseudo random BER test pattern will be presented to the local ST-BUS output channel.
  - **110** Per-channel high-impedance. The local ST-BUS output is high-impedance.
  - **111** Reserved

<table>
<thead>
<tr>
<th>Bit</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>12 - 8</td>
<td>LSAB4 - LSAB0</td>
<td><strong>Source Stream Address Bits:</strong> These five bits refer to the number of the data streams for the source (local or backplane) connection.</td>
</tr>
</tbody>
</table>

### Table 29 - Local Connection Memory Low Bits

<table>
<thead>
<tr>
<th>LTM2</th>
<th>LTM1</th>
<th>LTM0</th>
<th>Input Source</th>
<th>Var. delay</th>
<th>Const. delay</th>
<th>Msg Mode</th>
<th>BER</th>
<th>Output HiZ</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>0</td>
<td>0</td>
<td>Local</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>0</td>
<td>0</td>
<td>1</td>
<td>Local</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>0</td>
<td>Local</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>1</td>
<td>Local</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>0</td>
<td>Backplane</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>1</td>
<td>Backplane</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>1</td>
<td>1</td>
<td>0</td>
<td>Backplane</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>1</td>
<td>1</td>
<td>1</td>
<td>Reservesd</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>
### Table 29 - Local Connection Memory Low Bits (continued)

<table>
<thead>
<tr>
<th>Bit</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>7 - 0</td>
<td>LCAB7 - LCAB0</td>
<td><strong>Source Channel Address Bits</strong>: These eight bits refer to the number of the channel that is the source (local or backplane) connection.</td>
</tr>
</tbody>
</table>

Note 1: Only Bits 7-0 will be used for per-channel message mode for the local STo streams.

### Table 30 - LSAB and LCAB Bits Usage when Source Streams are from the Backplane Port

<table>
<thead>
<tr>
<th>Data Rate</th>
<th>Source Stream</th>
<th>LSAB Bit Usage</th>
<th>LCAB Bit Usage</th>
</tr>
</thead>
<tbody>
<tr>
<td>8 Mb/s</td>
<td>STi0-31</td>
<td>LSAB4-0</td>
<td>LCAB6-0 (128-ch/frame)</td>
</tr>
<tr>
<td>16 Mb/s</td>
<td>STi0-15</td>
<td>LSAB3-0</td>
<td>LCAB7-0 (256 ch/frame)</td>
</tr>
</tbody>
</table>

### Table 31 - LSAB and LCAB Bits Usage when Source Stream are from the Local Port

<table>
<thead>
<tr>
<th>Data Rate</th>
<th>Source Stream</th>
<th>LSAB Bit Usage</th>
<th>LCAB Bit Usage</th>
</tr>
</thead>
<tbody>
<tr>
<td>2 Mb/s</td>
<td>STi0-27</td>
<td>LSAB4-0</td>
<td>LCAB4-0 (32-ch/frame)</td>
</tr>
<tr>
<td>4 Mb/s</td>
<td>STi0-18</td>
<td>LSAB4-0</td>
<td>LCAB5-0 (64-ch/frame)</td>
</tr>
<tr>
<td>8 Mb/s</td>
<td>STi0-18</td>
<td>LSAB4-0</td>
<td>LCAB6-0 (128-ch/frame)</td>
</tr>
<tr>
<td>2-bit subrate</td>
<td>STi0-15</td>
<td>LSAB3-0</td>
<td>LCAB6-0 (128 ch/frame)</td>
</tr>
<tr>
<td>4-bit subrate</td>
<td>STi0-15</td>
<td>LSAB3-0</td>
<td>LCAB5 -0 (64 ch/frame)</td>
</tr>
</tbody>
</table>

Note: When operating at 4 Mb/s or 8 Mb/s, STo19-27 are driven low.
23.0 DC/AC Electrical Characteristics

Absolute Maximum Ratings*

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Min.</th>
<th>Max.</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 Supply Voltage</td>
<td>VDD</td>
<td>-0.5</td>
<td>5.0</td>
<td>V</td>
</tr>
<tr>
<td>2 BSTio Bias Voltage</td>
<td>VDD5V</td>
<td>-0.5</td>
<td>VDD + 0.5</td>
<td>V</td>
</tr>
<tr>
<td>3 Input Voltage</td>
<td>VI</td>
<td>-0.5</td>
<td>VDD + 0.5</td>
<td>V</td>
</tr>
<tr>
<td>4 Output Voltage</td>
<td>VO</td>
<td>-0.5</td>
<td>VDD + 0.5</td>
<td>V</td>
</tr>
<tr>
<td>5 Package power dissipation</td>
<td>PD</td>
<td>2</td>
<td></td>
<td>W</td>
</tr>
<tr>
<td>6 Storage temperature</td>
<td>TS</td>
<td>-55</td>
<td>+125</td>
<td>°C</td>
</tr>
</tbody>
</table>

* Exceeding these values may cause permanent damage. Functional operation under these conditions is not implied.

Recommended Operating Conditions - Voltages are with respect to ground (VSS) unless otherwise stated.

<table>
<thead>
<tr>
<th>Characteristics</th>
<th>Sym.</th>
<th>Min.</th>
<th>Typ.†</th>
<th>Max.</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 Operating Temperature</td>
<td>TOP</td>
<td>-40</td>
<td>25</td>
<td>+85</td>
<td>°C</td>
</tr>
<tr>
<td>2 Positive Supply</td>
<td>VDD</td>
<td>3.0</td>
<td>3.3</td>
<td>3.6</td>
<td>V</td>
</tr>
<tr>
<td>3 BSTio Bias Voltage (3 V PCI Spec)</td>
<td>VDD5V</td>
<td>3.0</td>
<td>3.3</td>
<td>3.6</td>
<td>V</td>
</tr>
<tr>
<td>4 BSTio Bias Voltage (5 V PCI Spec)</td>
<td>VDD5V</td>
<td>4.5</td>
<td>5.0</td>
<td>5.5</td>
<td>V</td>
</tr>
<tr>
<td>5 Input Voltage</td>
<td>VI</td>
<td>0</td>
<td>VDD</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>6 Input Voltage on 5 V Tolerant Inputs</td>
<td>V1_5V</td>
<td>0</td>
<td>VDD5V</td>
<td>V</td>
<td></td>
</tr>
</tbody>
</table>

† Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

DC Electrical Characteristics† - Voltages are with respect to ground (VSS) unless otherwise stated.

<table>
<thead>
<tr>
<th>Characteristics</th>
<th>Sym.</th>
<th>Min.</th>
<th>Typ.‡</th>
<th>Max.</th>
<th>Units</th>
<th>Test Conditions</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 Supply Current</td>
<td>IDD</td>
<td>480</td>
<td>mA</td>
<td></td>
<td></td>
<td>Output unloaded</td>
</tr>
<tr>
<td>2 Input High Voltage</td>
<td>VIH</td>
<td>0.7VDD</td>
<td>V</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>3 Input Low Voltage</td>
<td>VIL</td>
<td>0.3VDD</td>
<td>V</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>4 Input Leakage (input pins)</td>
<td>IL</td>
<td>15</td>
<td>µA</td>
<td></td>
<td></td>
<td>0 &lt; V &lt; VDD_IO</td>
</tr>
<tr>
<td>5 Weak Pullup Current</td>
<td>IPU</td>
<td>33</td>
<td>µA</td>
<td>50</td>
<td>µA</td>
<td>Input at 0V</td>
</tr>
<tr>
<td>6 Weak Pulldown Current</td>
<td>IPD</td>
<td>33</td>
<td>µA</td>
<td>50</td>
<td>µA</td>
<td>Input at VDD</td>
</tr>
<tr>
<td>7 Input Pin Capacitance</td>
<td>CI</td>
<td>5</td>
<td>pF</td>
<td>10</td>
<td>pF</td>
<td></td>
</tr>
<tr>
<td>8 Output High Voltage</td>
<td>VOH</td>
<td>0.8VDD</td>
<td>V</td>
<td></td>
<td></td>
<td>IOH = 10 mA</td>
</tr>
<tr>
<td>9 Output Low Voltage</td>
<td>VOL</td>
<td>0.4</td>
<td>V</td>
<td>10</td>
<td>µA</td>
<td>IOH = 10 mA</td>
</tr>
<tr>
<td>10 High Impedance Leakage</td>
<td>IOZ</td>
<td>5</td>
<td>µA</td>
<td></td>
<td></td>
<td>0 &lt; V &lt; VDD_IO</td>
</tr>
<tr>
<td>11 Output Pin Capacitance</td>
<td>CO</td>
<td>5</td>
<td>pF</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

† Characteristics are over recommended operating conditions unless otherwise stated.
‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.
* Note 1: Maximum leakage on pins (output or I/O pins in high impedance state) is over an applied voltage (Vin).
AC Electrical Characteristics - Timing Parameter Measurement Voltage Levels

<table>
<thead>
<tr>
<th>Characteristics</th>
<th>Sym.</th>
<th>Level</th>
<th>Units</th>
<th>Conditions</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 CMOS Threshold</td>
<td>$V_{CT}$</td>
<td>0.5$V_{DD}$</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>2 Rise/Fall Threshold Voltage High</td>
<td>$V_{HM}$</td>
<td>0.7$V_{DD}$</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>3 Rise/Fall Threshold Voltage Low</td>
<td>$V_{LM}$</td>
<td>0.3$V_{DD}$</td>
<td>V</td>
<td></td>
</tr>
</tbody>
</table>

AC Electrical Characteristics$^\dagger$ - Input Frame Pulse and Input Clock Timing

<table>
<thead>
<tr>
<th>Characteristic</th>
<th>Sym.</th>
<th>Min.</th>
<th>Typ.$^\ddagger$</th>
<th>Max.</th>
<th>Units</th>
<th>Notes</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 FRAME_A_io, FRAME_B_io Input Frame Pulse Width</td>
<td>$t_{CFPIW}$</td>
<td>90</td>
<td>122</td>
<td>180</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>2 FRAME_A_io, FRAME_B_io Input Frame Pulse Setup Time</td>
<td>$t_{CFPIS}$</td>
<td>45</td>
<td>90</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>3 FRAME_A_io, FRAME_B_io Input Frame Pulse Hold Time</td>
<td>$t_{CFPIH}$</td>
<td>45</td>
<td>90</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>4 C8_A_io, C8_B_io Input Clock Period</td>
<td>$t_{C8MIP}$</td>
<td>122-\phi</td>
<td>122+\phi</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>5 C8_A_io, C8_B_io Input Clock High Time</td>
<td>$t_{C8MIH}$</td>
<td>58-\phi</td>
<td>64+\phi</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>6 C8_A_io, C8_B_io Input Clock Low Time</td>
<td>$t_{C8MIL}$</td>
<td>58-\phi</td>
<td>64+\phi</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>7 Phase Correction</td>
<td>$\phi$</td>
<td>0</td>
<td>10</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>8 C8_A_io, C8_B_io Input Rise/Fall Time</td>
<td>$t_{C8i}$</td>
<td>$t_{C8i}$</td>
<td>$t_{C8i}$</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
</tbody>
</table>

$^\dagger$ Characteristics are over recommended operating conditions unless otherwise stated.

$^\ddagger$ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

---

**Figure 22 - Backplane Frame Pulse Input and Clock Input Timing Diagram**

---

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Zarlink Semiconductor Inc.

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## AC Electrical Characteristics† - Output Frame Pulse and Output Clock Timing

<table>
<thead>
<tr>
<th>Characteristic</th>
<th>Sym.</th>
<th>Min.</th>
<th>Typ.‡</th>
<th>Max.</th>
<th>Units</th>
<th>Notes</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 Internal Timing Variation</td>
<td>Δ*</td>
<td>6.50</td>
<td>7.50</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>2 Backplane Frame Boundary Offset</td>
<td>tFBOS</td>
<td>1.25-Δ</td>
<td>2.5+Δ</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>3 FRAME_A_io, FRAME_B_io Output Pulse Width</td>
<td>tCFPOW</td>
<td>122-Δ</td>
<td>122+Δ</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>4 Delay from FRAME_A_io, FRAME_B_io output falling edge to C8_a_io,C8_B_io output rising edge</td>
<td>tCFODF</td>
<td>61-Δ/2</td>
<td>61+Δ/2</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>5 Delay from C8_a_io,C8_B_io output rising edge to FRAME_A_io,FRAME_B_io output rising edge</td>
<td>tCFODR</td>
<td>61-Δ/2</td>
<td>61+Δ/2</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>6 C8_A_io, C8_B_io Output Clock Period</td>
<td>tC8MP</td>
<td>122-Δ</td>
<td>122+Δ</td>
<td></td>
<td>ns</td>
<td>C\textsubscript{L}=30pF</td>
</tr>
<tr>
<td>7 C8_A_io, C8_B_io Output High Time</td>
<td>tC8MH</td>
<td>61-Δ/2</td>
<td>61+Δ/2</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>8 C8_A_io, C8_B_io Output Low Time</td>
<td>tC8ML</td>
<td>61-Δ/2</td>
<td>61+Δ/2</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>9 C8_A_io, C8_B_io Output Rise Time</td>
<td>tC8o</td>
<td>13</td>
<td></td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>10 C8_A_io, C8_B_io Output Fall Time</td>
<td>tC8o</td>
<td>14</td>
<td></td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>11 C32/64o (32.768 MHz) Output Delay Time</td>
<td>tC32MOD</td>
<td>Δ</td>
<td></td>
<td></td>
<td>ns</td>
<td>C\textsubscript{L}=30pF</td>
</tr>
<tr>
<td>12 C32/64o (32.768 MHz) Period</td>
<td>tC32MP</td>
<td>30.5-Δ</td>
<td>30.5+Δ</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>13 C32/64o (32.768 MHz) High Time</td>
<td>tC32MH</td>
<td>15.25-Δ/2</td>
<td>15.25+Δ/2</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>14 C32/64o (32.768 MHz) Low Time</td>
<td>tC32ML</td>
<td>15.25-Δ/2</td>
<td>15.25+Δ/2</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>15 C32/64o (65.536 MHz) Period</td>
<td>tC64MP</td>
<td>15.25-Δ/2</td>
<td>15.25+Δ/2</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>16 C32/64o (65.536 MHz) High Time</td>
<td>tC64MH</td>
<td>Δ</td>
<td>0.5+Δ</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>17 C32/64o (65.536 MHz) Low Time</td>
<td>tC64ML</td>
<td>Δ</td>
<td>5.5+Δ</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>18 C32/64o Clock Rise Time (32.768 MHz or 65.536 MHz)</td>
<td>t\textsubscript{C32o}</td>
<td>5</td>
<td></td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>19 C32/64o Clock Fall Time (32.768 MHz or 65.536 MHz)</td>
<td>t\textsubscript{C32o}</td>
<td>6</td>
<td></td>
<td></td>
<td>ns</td>
<td></td>
</tr>
</tbody>
</table>

† Characteristics are over recommended operating conditions unless otherwise stated.
‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

* The AC electrical characteristics are listed as a function of the internal timing variation (Δ) to highlight the value of each parameter independent of the variation. It is important to choose the maximum or minimum Δ value correctly for worst case timing calculation. When adding parameters for timing calculation, it is sufficient to include this Δ only once in the calculation.
### AC Electrical Characteristics† - C20i Master Input Clock Timing

<table>
<thead>
<tr>
<th>Characteristic</th>
<th>Sym.</th>
<th>Min.</th>
<th>Typ. ‡</th>
<th>Max.</th>
<th>Units</th>
<th>Notes</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 C20i Input Clock Period</td>
<td>$t_{C20MP}$</td>
<td>49.995</td>
<td>50</td>
<td>50.005</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>2 C20i Input Clock Tolerance</td>
<td>$t_{C20}$</td>
<td>-100</td>
<td></td>
<td>100</td>
<td>ppm</td>
<td></td>
</tr>
<tr>
<td>3 C20i Input Clock High Time</td>
<td>$t_{C20MH}$</td>
<td>20</td>
<td></td>
<td>30</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>4 C20i Input Clock Low Time</td>
<td>$t_{C20ML}$</td>
<td>20</td>
<td></td>
<td>30</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>5 C20i Input Rise/Fall Time</td>
<td>$t_{C20M}$, $t_{C20}$</td>
<td>10</td>
<td></td>
<td></td>
<td>ns</td>
<td></td>
</tr>
</tbody>
</table>

† Characteristics are over recommended operating conditions unless otherwise stated.
‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

---

Figure 23 - Backplane Frame Pulse Output and Clock Output Timing Diagram (in Primary Master Mode and Secondary Master Mode)

Figure 24 - Backplane Frame Pulse Input and Clock Input Timing Diagram
### AC Electrical Characteristics

<table>
<thead>
<tr>
<th>Characteristic</th>
<th>Sym.</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Units</th>
<th>Notes</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 CTREF1, CTREF2, LREF0-7 Period</td>
<td>tR8KP</td>
<td>121</td>
<td>125</td>
<td>129</td>
<td>µs</td>
<td>8 kHz Mode</td>
</tr>
<tr>
<td>2 CTREF1, CTREF2, LREF0-7 High Time</td>
<td>tR8kh</td>
<td>0.09</td>
<td>128.91</td>
<td>128.91</td>
<td>µs</td>
<td></td>
</tr>
<tr>
<td>3 CTREF1, CTREF2, LREF0-7 Low Time</td>
<td>tR8KL</td>
<td>0.09</td>
<td>128.91</td>
<td>128.91</td>
<td>µs</td>
<td></td>
</tr>
<tr>
<td>4 CTREF1, CTREF2, LREF0-7 Rise/Fall Time</td>
<td>tR8K, tR8K</td>
<td>0</td>
<td>20</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>5 CTREF1, CTREF2, LREF0-7 Period</td>
<td>tR2MP</td>
<td>366</td>
<td>488</td>
<td>610</td>
<td>ns</td>
<td>2.048 MHz Mode</td>
</tr>
<tr>
<td>6 CTREF1, CTREF2, LREF0-7 High Time</td>
<td>tR2Mh</td>
<td>90</td>
<td>244</td>
<td>520</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>7 CTREF1, CTREF2, LREF0-7 Low Time</td>
<td>tR2ML</td>
<td>90</td>
<td>244</td>
<td>520</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>8 CTREF1, CTREF2, LREF0-7 Rise/Fall Time</td>
<td>tR2M, tR2M</td>
<td>0</td>
<td>20</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>9 CTREF1, CTREF2, LREF0-7 Period</td>
<td>tR1M5P</td>
<td>486</td>
<td>648</td>
<td>810</td>
<td>ns</td>
<td>1.544 MHz Mode</td>
</tr>
<tr>
<td>10 CTREF1, CTREF2, LREF0-7 High Time</td>
<td>tR1M5h</td>
<td>90</td>
<td>324</td>
<td>720</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>11 CTREF1, CTREF2, LREF0-7 Low Time</td>
<td>tR1M5L</td>
<td>90</td>
<td>324</td>
<td>720</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>12 CTREF1, CTREF2, LREF0-7 Rise/Fall Time</td>
<td>tR1M5, tR1M5</td>
<td>0</td>
<td>20</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

† Characteristics are over recommended operating conditions unless otherwise stated.
‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

---

![Figure 25 - Reference Input Timing Diagram when the input frequency = 8 kHz](image1)

![Figure 26 - Reference Input Timing Diagram when the input frequency = 2.048 MHz](image2)

![Figure 27 - Reference Input Timing Diagram when the input frequency = 1.544 Hz](image3)
### AC Electrical Characteristics† - Reference Output Timing

<table>
<thead>
<tr>
<th>Characteristic</th>
<th>Sym.</th>
<th>Min.</th>
<th>Typ.†</th>
<th>Max.</th>
<th>Units</th>
<th>Notes</th>
</tr>
</thead>
<tbody>
<tr>
<td>NREFo Output Delay Time</td>
<td>$t_{ROD}$</td>
<td></td>
<td></td>
<td>20</td>
<td>ns</td>
<td>(DIV1,DIV0) = (0,0)</td>
</tr>
<tr>
<td>NREFo Clock Period</td>
<td>$t_{RP}$</td>
<td></td>
<td>Same as LREF0-7 Period</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>NREFo Clock High Time</td>
<td>$t_{RH}$</td>
<td></td>
<td>Same as LREF0-7 High Time</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>NREFo Clock Low Time</td>
<td>$t_{RL}$</td>
<td></td>
<td>Same as LREF0-7 Low Time</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>NREFo Clock Rise/Fall Time</td>
<td>$t_{REF}$</td>
<td>0</td>
<td></td>
<td>12</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td></td>
<td>$t_{REF}$</td>
<td>14</td>
<td></td>
<td>12.1</td>
<td>µs</td>
<td></td>
</tr>
<tr>
<td>NREFo Clock Period</td>
<td>$t_{R8KOP}$</td>
<td>124.9</td>
<td>125</td>
<td>125.1</td>
<td>µs</td>
<td>(DIV1,DIV0) = (0,1) or (DIV1,DIV0) = (1,0)</td>
</tr>
<tr>
<td>NREFo Clock High Time</td>
<td>$t_{R8KO2H}$</td>
<td>124.4</td>
<td>124.5</td>
<td>124.6</td>
<td>µs</td>
<td></td>
</tr>
<tr>
<td>NREFo Clock Low Time</td>
<td>$t_{R8KO2L}$</td>
<td>488-$\Delta$</td>
<td>488</td>
<td>488+$\Delta$</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>NREFo Clock High Time</td>
<td>$t_{R8KO15H}$</td>
<td>124.3</td>
<td>124.4</td>
<td>124.5</td>
<td>µs</td>
<td></td>
</tr>
<tr>
<td>NREFo Clock Low Time</td>
<td>$t_{R8KO15L}$</td>
<td>648-$\Delta$</td>
<td>648</td>
<td>648+$\Delta$</td>
<td>ns</td>
<td></td>
</tr>
</tbody>
</table>

† Characteristics are over recommended operating conditions unless otherwise stated.
‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

![Figure 28 - Reference Output Timing Diagram when (DIV1, DIV0) = (0, 0) in DOM2 Register](image1)

![Figure 29 - Reference Output Timing Diagram when (DIV1, DIV0) = (0, 0) in DOM2 Register](image2)

![Figure 30 - Reference Input Timing Diagram when (DIV1, DIV0) = (0, 0) in DOM2 Register](image3)

![Figure 31 - Reference Output Timing Diagram when (DIV1, DIV0) = (1, 0) in DOM2 Register](image4)
**AC Electrical Characteristics**† - Local Frame Pulse and Clock Timing, **\( \text{ST\_CKo} = 4.096 \text{ MHz} \)**

<table>
<thead>
<tr>
<th>Characteristic</th>
<th>Sym.</th>
<th>Min.</th>
<th>Typ.‡</th>
<th>Max.</th>
<th>Units</th>
<th>Notes</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 Local Frame Boundary Offset†</td>
<td>( t_{\text{LFBOS}} )</td>
<td>( \Delta )</td>
<td>( 17.5 + \Delta ) ns</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>2 ST_FPo0/1 Width</td>
<td>( t_{\text{FPW4}} )</td>
<td>244-( \Delta )</td>
<td>244</td>
<td>244+( \Delta ) ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>3 ST_FPo0/1 Output Delay from Falling edge of ST_FPo0/1 to falling edge of ST_CKo0/1</td>
<td>( t_{\text{FODF4}} )</td>
<td>122-( \Delta/2 )</td>
<td>122+( \Delta/2 ) ns</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>4 ST_FPo 0/1 Output Delay from Falling edge of ST_CKo0/1 to rising edge of ST_FPo0/1</td>
<td>( t_{\text{FODR4}} )</td>
<td>122-( \Delta/2 )</td>
<td>122+( \Delta/2 ) ns</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>5 ST_CKo0/1 Clock Period</td>
<td>( t_{\text{CP4}} )</td>
<td>244-( \Delta )</td>
<td>244</td>
<td>244+( \Delta ) ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>6 ST_CKo0/1 Clock Pulse Width High</td>
<td>( t_{\text{CH4}} )</td>
<td>122-( \Delta/2 )</td>
<td>122+( \Delta/2 ) ns</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>7 ST_CKo0/1 Clock Pulse Width Low</td>
<td>( t_{\text{CL4}} )</td>
<td>122-( \Delta/2 )</td>
<td>122+( \Delta/2 ) ns</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>8 ST_CKo0/1 Clock Rise/Fall Time</td>
<td>( t_{\text{C4o}} ), ( t_{\text{C4o}} )</td>
<td>14</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

† Characteristics are over recommended operating conditions unless otherwise stated.
‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

**Note 1**: No jitter presented on input reference clock.

---

**Figure 32 - Reference Output Timing Diagram when \((\text{DIV1, DIV0}) = (0, 1)\) in DOM2 Register**

---

**Figure 33 - Local Clock Timing Diagram when **\( \text{ST\_CKo0/1 frequency} = 4.096 \text{ MHz} \)**
AC Electrical Characteristics† - Local Frame Pulse and Clock Timing, ST_CKo0 = 8.192 MHz

<table>
<thead>
<tr>
<th>Characteristic</th>
<th>Sym.</th>
<th>Min.</th>
<th>Typ.‡</th>
<th>Max.</th>
<th>Units</th>
<th>Notes</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 Local Frame Boundary Offset†</td>
<td>tLFBOS</td>
<td>Δ</td>
<td>17.5+Δ</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>2 ST_FPo0/1 Width</td>
<td>tFPW8</td>
<td>122-Δ</td>
<td>122</td>
<td>122+Δ</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>3 ST_FPo0/1 Output Delay from Falling edge of ST_FPo0/1 to falling edge of ST_CKo0/1</td>
<td>tFODF8</td>
<td>61-Δ/2</td>
<td>61+Δ/2</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>4 ST_FPo0/1 Output Delay from Falling edge of ST_CKo0/1 to rising edge of ST_FPo0/1</td>
<td>tFODR8</td>
<td>61-Δ/2</td>
<td>61+Δ/2</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>5 ST_CKo0/1 Clock Period</td>
<td>tCP8</td>
<td>122-Δ</td>
<td>122</td>
<td>122+Δ</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>6 ST_CKo0/1 Clock Pulse Width High</td>
<td>tCH8</td>
<td>61-Δ/2</td>
<td>61+Δ/2</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>7 ST_CKo0/1 Clock Pulse Width Low</td>
<td>tCL8</td>
<td>61-Δ/2</td>
<td>61+Δ/2</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>8 ST_CKo0/1 Clock Rise/Fall Time</td>
<td>tC8o</td>
<td>14</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

† Characteristics are over recommended operating conditions unless otherwise stated.
‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

Note 1: No jitter presented on input reference clock.

![Figure 34 - Local Clock Timing Diagram when ST_CKo0/1 frequency = 8.192 MHz](Downloaded from Arrow.com.)
AC Electrical Characteristics† - Local Frame Pulse and Clock Timing, ST_CKo = 16.384 MHz

<table>
<thead>
<tr>
<th>Characteristic</th>
<th>Sym.</th>
<th>Min.</th>
<th>Typ.‡</th>
<th>Max.</th>
<th>Units</th>
<th>Notes</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 Local Frame Boundary Offset†</td>
<td>t_{LFBOS}</td>
<td>Δ</td>
<td>17+Δ</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>2 ST_FPo0/1 Width</td>
<td>t_{FPW16}</td>
<td>61-Δ</td>
<td>61</td>
<td>61+Δ</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>3 ST_FPo0/1 Output Delay from Falling edge of ST_FPo0/1 to falling edge of ST_CKo0/1</td>
<td>t_{FODF16}</td>
<td>30.5-Δ/2</td>
<td>30.5+Δ/2</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>4 ST_FPo0/1 Output Delay from Falling edge of ST_CKo0/1 to rising edge of ST_FPo0/1</td>
<td>t_{FODR16}</td>
<td>30.5-Δ/2</td>
<td>30.5+Δ/2</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>5 ST_CKo0/1 Clock Period</td>
<td>t_{CP16}</td>
<td>61-Δ</td>
<td>61</td>
<td>61+Δ</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>6 ST_CKo0/1 Clock Pulse Width High</td>
<td>t_{Ch16}</td>
<td>30.5-Δ/2</td>
<td>30.5+Δ/2</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>7 ST_CKo0/1 Clock Pulse Width Low</td>
<td>t_{CL16}</td>
<td>30.5-Δ/2</td>
<td>30.5+Δ/2</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>8 ST_CKo0/1 Clock Rise/Fall Time</td>
<td>t_{fC16o}, t_{rC16o}</td>
<td>14</td>
<td>14</td>
<td>14</td>
<td>ns</td>
<td></td>
</tr>
</tbody>
</table>

† Characteristics are over recommended operating conditions unless otherwise stated.
‡ Typical figures are at 25°C and are for design aid only; not guaranteed and not subject to production testing.
Note 1: No jitter presented on input reference clock.

![Figure 35 - Local Clock Timing Diagram when ST_CKo frequency = 16.384 MHz](image-url)
AC Electrical Characteristics†- C1M5o Output Clock Timing

<table>
<thead>
<tr>
<th>Characteristic</th>
<th>Sym.</th>
<th>Min.</th>
<th>Typ.‡</th>
<th>Max.</th>
<th>Units</th>
<th>Notes</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 C1M5o Period</td>
<td>tC1M5oP</td>
<td>648-Δ</td>
<td>648</td>
<td>648+Δ</td>
<td>ns</td>
<td>C₂=30 pF</td>
</tr>
<tr>
<td>2 C1M5o High Time</td>
<td>tC1M5oH</td>
<td>324-Δ/2</td>
<td>324</td>
<td>324+Δ/2</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>3 C1M5o Low Time</td>
<td>tC1M5oL</td>
<td>324-Δ/2</td>
<td>324</td>
<td>324+Δ/2</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>4 C1M5o Rise Time</td>
<td>tC1M5oR</td>
<td>324-Δ/2</td>
<td>324</td>
<td>324+Δ/2</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>5 C1M5o Fall Time</td>
<td>tC1M5oF</td>
<td>324-Δ/2</td>
<td>324</td>
<td>324+Δ/2</td>
<td>ns</td>
<td></td>
</tr>
</tbody>
</table>

† Characteristics are over recommended operating conditions unless otherwise stated.
‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

AC Electrical Characteristics†- Output Clock Jitter Generation (Unfiltered)

<table>
<thead>
<tr>
<th>Characteristic</th>
<th>Typ.‡</th>
<th>Max.</th>
<th>Units</th>
<th>Notes</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 Jitter at C1M5o (1.544 MHz)</td>
<td>7.4</td>
<td>8.0</td>
<td>ns-pp</td>
<td>Device locks to 1.544 MHz reference input, and no jitter present on the reference</td>
</tr>
<tr>
<td>2 Jitter at ST_CLKo0-1 (4.096 MHz)</td>
<td>7.1</td>
<td>8.8</td>
<td>ns-pp</td>
<td></td>
</tr>
<tr>
<td>3 Jitter at ST_CLKo0-1 (8.192 MHz)</td>
<td>7.0</td>
<td>8.3</td>
<td>ns-pp</td>
<td></td>
</tr>
<tr>
<td>4 Jitter at ST_CLKo0-1 (16.384 MHz)</td>
<td>7.6</td>
<td>9.9</td>
<td>ns-pp</td>
<td></td>
</tr>
</tbody>
</table>

† Characteristics are over recommended operating conditions unless otherwise stated.
‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.
AC Electrical Characteristics† - Backplane Serial Streams with Data Rate of 8 Mb/s

<table>
<thead>
<tr>
<th>Characteristic</th>
<th>Sym.</th>
<th>Min.‡</th>
<th>Typ.‡</th>
<th>Max.</th>
<th>Units</th>
<th>Test Conditions</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 STio0-31 Input Data Sample Point</td>
<td>tSAMP8</td>
<td>91.5</td>
<td>91.5</td>
<td>91.5</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>2 STio0-31 Input Setup Time</td>
<td>tCIS8</td>
<td>5+Δ</td>
<td></td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>3 STio0-31 Input Hold Time</td>
<td>tCIH8</td>
<td>5+Δ</td>
<td></td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>4 STio0-31 Output Delay Active to Active</td>
<td>tDOD8</td>
<td>1-Δ</td>
<td>5+Δ</td>
<td></td>
<td>ns</td>
<td>C_L = 30 pF, Note 1</td>
</tr>
<tr>
<td>5 Per Channel boundary HiZ</td>
<td>tDOZ8</td>
<td>10</td>
<td></td>
<td></td>
<td>ns</td>
<td>R_L = 1K, C_L = 30 pF, Note 2</td>
</tr>
<tr>
<td></td>
<td>tZDO8</td>
<td></td>
<td></td>
<td></td>
<td>ns</td>
<td></td>
</tr>
</tbody>
</table>

† Characteristics are over recommended operating conditions unless otherwise stated.
‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.
* Note 1: To meet the H.110 output timing requirement, the output delay time can be reduced further by programming the backplane output advancement registers (BOA0 - 3).
* Note 2: High Impedance is measured by pulling to the appropriate rail with R_L, with timing corrected to cancel the time taken to discharge C_L.

![Figure 37 - Backplane Serial Stream Timing when the Data Rate is 8 Mb/s](image-url)
## AC Electrical Characteristics† - Backplane Serial Streams with Data Rate of 16 Mb/s

<table>
<thead>
<tr>
<th>Characteristic</th>
<th>Sym.</th>
<th>Min.</th>
<th>Typ.‡</th>
<th>Max.</th>
<th>Units</th>
<th>Test Conditions</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 STio0-15 Input Data Sample Point</td>
<td>$t_{\text{SAMP}16}$</td>
<td>46</td>
<td>46</td>
<td>46</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>2 STio0-15 Input Setup Time</td>
<td>$t_{\text{CIS}16}$</td>
<td>5+*</td>
<td></td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>3 STio0-15 Input Hold Time</td>
<td>$t_{\text{CIH}16}$</td>
<td>5+*</td>
<td></td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>4 STio0-15 Output Delay Active to Active</td>
<td>$t_{\text{ODD}16}$</td>
<td>1-*</td>
<td>5+*</td>
<td></td>
<td>ns</td>
<td>$C_L = 30 \text{ pF}$</td>
</tr>
</tbody>
</table>

† Characteristics are over recommended operating conditions unless otherwise stated.
‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

![Figure 38 - Backplane Serial Stream Timing when the Data Rate is 16 Mb/s](image-url)
### AC Electrical Characteristics† - Local Serial Stream Output Timing

<table>
<thead>
<tr>
<th>Characteristic</th>
<th>Sym.</th>
<th>Min.</th>
<th>Typ.‡</th>
<th>Max.</th>
<th>Units</th>
<th>Test Conditions</th>
</tr>
</thead>
<tbody>
<tr>
<td>STo Delay - Active to Active</td>
<td>tSOD2</td>
<td>-10-Δ*</td>
<td>1.5-Δ*</td>
<td>ns</td>
<td>CL = 30 pF</td>
<td></td>
</tr>
<tr>
<td>@2.048 Mb/s</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>@4.096 Mb/s</td>
<td>tSOD4</td>
<td>-10-Δ*</td>
<td>1.5-Δ*</td>
<td>ns</td>
<td>CL = 30 pF</td>
<td></td>
</tr>
<tr>
<td>@8.192 Mb/s</td>
<td>tSOD8</td>
<td>-10-Δ*</td>
<td>1.5-Δ*</td>
<td>ns</td>
<td>CL = 30 pF</td>
<td></td>
</tr>
</tbody>
</table>

† Characteristics are over recommended operating conditions unless otherwise stated.
‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.
* See Section 7.0, “Local Output Timing Considerations” on page 21

---

![Figure 39 - Local Serial Stream Output Timing](image-url)
### AC Electrical Characteristics† - Local Serial Stream Input Timing

<table>
<thead>
<tr>
<th>Characteristic</th>
<th>Sym.</th>
<th>Min.</th>
<th>Typ.‡</th>
<th>Max.</th>
<th>Units</th>
<th>Test Conditions</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 STi Input Data Sample Point</td>
<td>t_{SAMP2L}</td>
<td>366</td>
<td>366</td>
<td>366</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>@2.048 Mb/s</td>
<td>t_{SAMP4L}</td>
<td>183</td>
<td>183</td>
<td>183</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>@4.096 Mb/s</td>
<td>t_{SAMP8L}</td>
<td>91.5</td>
<td>91.5</td>
<td>91.5</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>2 STi Setup Time</td>
<td>t_{SIS2}</td>
<td>5+Δ</td>
<td></td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>@2.048 Mb/s</td>
<td>t_{SIS4}</td>
<td>5+Δ</td>
<td></td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>@4.096 Mb/s</td>
<td>t_{SIS8}</td>
<td>5+Δ</td>
<td></td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>3 STi Hold Time</td>
<td>t_{SIH2}</td>
<td>5+Δ</td>
<td></td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>@2.048 Mb/s</td>
<td>t_{SIH4}</td>
<td>5+Δ</td>
<td></td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>@4.096 Mb/s</td>
<td>t_{SHI8}</td>
<td>5+Δ</td>
<td></td>
<td></td>
<td>ns</td>
<td></td>
</tr>
</tbody>
</table>

![Figure 40 - Local Serial Stream Input Timing](image_url)

**Figure 40 - Local Serial Stream Input Timing**
### AC Electrical Characteristics† - Local and Backplane Tristate Timing

<table>
<thead>
<tr>
<th>Characteristic</th>
<th>Sym.</th>
<th>Min.</th>
<th>Typ.‡</th>
<th>Max.</th>
<th>Units</th>
<th>Test Conditions</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 STo/STio Delay - Active to High-Z</td>
<td>t(\text{ZD}, t(\text{ZD})</td>
<td>-12-∆</td>
<td>3.5-∆</td>
<td>ns</td>
<td>R(_L)=1,k\Omega, C(_L)=30,pF, See Note 1.</td>
<td></td>
</tr>
<tr>
<td>- High-Z to Active</td>
<td>2.048 Mb/s (local)</td>
<td>t(\text{ZD})</td>
<td>-12-∆</td>
<td>3.5-∆</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>4.096 Mb/s (local)</td>
<td>t(\text{ZD})</td>
<td>-12-∆</td>
<td>3.5-∆</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>8.192 Mb/s (local)</td>
<td>t(\text{ZD})</td>
<td>-1-∆</td>
<td>7+∆</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>8.192 Mb/s (backplane)</td>
<td>t(\text{ZD})</td>
<td>-1-∆</td>
<td>7+∆</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>16.384 Mb/s (backplane)</td>
<td>t(\text{ZD})</td>
<td>-1-∆</td>
<td>7+∆</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>2 Output Driver Enable (ODE) Delay</td>
<td>t(\text{ZD}_{\text{ODE}})</td>
<td>37 ns</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>- High-Z to Active</td>
<td>2.048 Mb/s (local)</td>
<td>t(\text{ZD}_{\text{ODE}})</td>
<td>37 ns</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>4.096 Mb/s (local)</td>
<td>t(\text{ZD}_{\text{ODE}})</td>
<td>37 ns</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>8.192 Mb/s (local)</td>
<td>t(\text{ZD}_{\text{ODE}})</td>
<td>37 ns</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>8.192 Mb/s (backplane)</td>
<td>t(\text{ZD}_{\text{ODE}})</td>
<td>20 ns</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>16.384 Mb/s (backplane)</td>
<td>t(\text{ZD}_{\text{ODE}})</td>
<td>20 ns</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>2 Output Driver Disable (ODE) Delay</td>
<td>t(\text{ZD}_{\text{ODE}})</td>
<td>20 ns</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>- Active to High-Z</td>
<td>2.048 Mb/s (local)</td>
<td>t(\text{ZD}_{\text{ODE}})</td>
<td>20 ns</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>4.096 Mb/s (local)</td>
<td>t(\text{ZD}_{\text{ODE}})</td>
<td>20 ns</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>8.192 Mb/s (local)</td>
<td>t(\text{ZD}_{\text{ODE}})</td>
<td>20 ns</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>8.192 Mb/s (backplane)</td>
<td>t(\text{ZD}_{\text{ODE}})</td>
<td>20 ns</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>16.384 Mb/s (backplane)</td>
<td>t(\text{ZD}_{\text{ODE}})</td>
<td>20 ns</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

† Characteristics are over recommended operating conditions unless otherwise stated.
‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.
* Note 1: High Impedance is measured by pulling to the appropriate rail with R\(_L\), with timing corrected to cancel the time taken to discharge C\(_L\).
Figure 42 - Backplane Serial Output and External Control

Figure 43 - Output Driver Enable (ODE)
## AC Electrical Characteristics† - Motorola Non-Multiplexed Bus Mode

<table>
<thead>
<tr>
<th>Characteristics</th>
<th>Sym.</th>
<th>Min.</th>
<th>Typ.‡</th>
<th>Max.</th>
<th>Units</th>
<th>Test Conditions¹</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 CS setup from DS falling</td>
<td>t&lt;sub&gt;CSS&lt;/sub&gt;</td>
<td>0 ns</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>2 R/W setup from DS falling</td>
<td>t&lt;sub&gt;RWS&lt;/sub&gt;</td>
<td>15 ns</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>3 Address setup from DS falling</td>
<td>t&lt;sub&gt;ADS&lt;/sub&gt;</td>
<td>5 ns</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>4 CS hold after DS rising</td>
<td>t&lt;sub&gt;CSH&lt;/sub&gt;</td>
<td>0 ns</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>5 R/W hold after DS rising</td>
<td>t&lt;sub&gt;RWH&lt;/sub&gt;</td>
<td>0 ns</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>6 Address hold after DS rising</td>
<td>t&lt;sub&gt;ADH&lt;/sub&gt;</td>
<td>5 ns</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>7 Data setup from DTA Low on Read</td>
<td>t&lt;sub&gt;DDR&lt;/sub&gt;</td>
<td>20 ns</td>
<td></td>
<td></td>
<td></td>
<td>C&lt;sub&gt;L&lt;/sub&gt;=30pF</td>
</tr>
<tr>
<td>8 Data hold on read</td>
<td>t&lt;sub&gt;DHR&lt;/sub&gt;</td>
<td>20 ns</td>
<td></td>
<td></td>
<td></td>
<td>C&lt;sub&gt;L&lt;/sub&gt;=30pF, R&lt;sub&gt;L&lt;/sub&gt;=1K</td>
</tr>
<tr>
<td>9 Valid Write Data Setup</td>
<td>t&lt;sub&gt;WDS&lt;/sub&gt;</td>
<td>20 ns</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>10 Data hold on write</td>
<td>t&lt;sub&gt;DHW&lt;/sub&gt;</td>
<td>8 ns</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>11 Acknowledgment Delay: Reading/Writing Registers</td>
<td>t&lt;sub&gt;AKD&lt;/sub&gt;</td>
<td>97/82 ns</td>
<td>158/114 ns</td>
<td>110/95 ns</td>
<td>171/127 ns</td>
<td>C&lt;sub&gt;L&lt;/sub&gt;=30pF C&lt;sub&gt;L&lt;/sub&gt;=30pF</td>
</tr>
<tr>
<td>12 Acknowledgment Hold Time</td>
<td>t&lt;sub&gt;AKH&lt;/sub&gt;</td>
<td>30 ns</td>
<td></td>
<td></td>
<td></td>
<td>C&lt;sub&gt;L&lt;/sub&gt;=30pF, R&lt;sub&gt;L&lt;/sub&gt;=1K</td>
</tr>
</tbody>
</table>

† Characteristics are over recommended operating conditions unless otherwise stated.
‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

*Note 1: A delay of 100 microseconds must be applied before the first microprocessor access is performed after the RESET pin is set high.
*Note 2: High Impedance is measured by pulling to the appropriate rail with R<sub>L</sub>, with timing corrected to cancel the time taken to discharge C<sub>L</sub>.

---

![Figure 44 - Motorola Non-Multiplexed Bus Timing](image-url)
AC Electrical Characteristics† - JTAG Test Port and Reset Pin Timing

<table>
<thead>
<tr>
<th>Characteristic</th>
<th>Sym.</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Units</th>
<th>Notes</th>
</tr>
</thead>
<tbody>
<tr>
<td>TCK Clock Period</td>
<td>tTCKP</td>
<td>200</td>
<td>500</td>
<td>500</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>TCK Clock Pulse Width High</td>
<td>tTCKH</td>
<td>80</td>
<td>100</td>
<td>100</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>TCK Clock Pulse Width Low</td>
<td>tTCKL</td>
<td>80</td>
<td>100</td>
<td>100</td>
<td>ns</td>
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</tr>
<tr>
<td>TMS Set-up Time</td>
<td>tTMSS</td>
<td>10</td>
<td>10</td>
<td>10</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>TMS Hold Time</td>
<td>tTMSH</td>
<td>10</td>
<td>10</td>
<td>10</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>TDi Input Set-up Time</td>
<td>tTDIS</td>
<td>20</td>
<td>20</td>
<td>20</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>TDi Input Hold Time</td>
<td>tTDIH</td>
<td>20</td>
<td>20</td>
<td>20</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>TDo Output Delay</td>
<td>tTDOD</td>
<td>30</td>
<td>30</td>
<td>30</td>
<td>ns</td>
<td>C_L=30pF</td>
</tr>
<tr>
<td>TRST pulse width</td>
<td>tTRSTW</td>
<td>20</td>
<td>20</td>
<td>20</td>
<td>ns</td>
<td>C_L=30pF</td>
</tr>
<tr>
<td>Reset pulse width</td>
<td>tRSTW</td>
<td>400</td>
<td>400</td>
<td>400</td>
<td>ns</td>
<td></td>
</tr>
</tbody>
</table>

† Characteristics are over recommended operating conditions unless otherwise stated.

Figure 45 - JTAG Test Port Timing Diagram

Figure 46 - Reset Pin Timing Diagram
24.0 Trademarks

CompactPCI® is a registered trademark of PICMG-PCI Industrial Computer Manufacturers Group, Inc.
1. Controlling dimensions are in mm.
2. Seating plane is defined by the spherical crown of the solder balls.
3. Not to scale.
4. N is the number of solder balls.
5. Substrate thickness is 0.56 mm.

NOTES:

Conforms to JEDEC MS-034

<table>
<thead>
<tr>
<th>Dimension</th>
<th>MIN</th>
<th>MAX</th>
</tr>
</thead>
<tbody>
<tr>
<td>A1</td>
<td>2.13</td>
<td>2.53</td>
</tr>
<tr>
<td>A2</td>
<td>2.17</td>
<td>2.20</td>
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<tr>
<td>D1</td>
<td>2.40</td>
<td>2.70</td>
</tr>
<tr>
<td>E1</td>
<td>2.40</td>
<td>2.70</td>
</tr>
<tr>
<td>E2</td>
<td>2.60</td>
<td>2.90</td>
</tr>
<tr>
<td>G0</td>
<td>0.60</td>
<td>0.90</td>
</tr>
<tr>
<td>G1</td>
<td>2.40</td>
<td>2.70</td>
</tr>
<tr>
<td>L1</td>
<td>1.17</td>
<td>1.27</td>
</tr>
</tbody>
</table>

Bottom View

Top View

Side View